



## Low-Cost, 8-Channel, Integrated Analog Front-End for Metering Applications

Check for Samples: [ADS130E08](#)

### FEATURES

- **Eight Differential Current and Voltage Inputs**
- **Eight Low-Noise PGAs and Eight High-Resolution ADCs**
- **Exceeds Class 1.0 Performance**
- **CMRR: –110 dB**
- **Crosstalk: –105 dB**
- **THD: –108 dB**
- **Power: 750  $\mu$ W/Channel**
- **Data Rates: 8 kSPS**
- **Programmable Gains (1, 2, and 8)**
- **DC Coupling:**
  - Dual Supplies: +3 V to +5 V or +1.8 V to +3.6 V
  - Bipolar Supply:  $\pm 2.5$  V
- **Built-In Test Signals**
- **Fault Detection Comparators**
- **Four GPIO Pins**
- **Internal and External Reference**
- **Flexible Power-Down: STBY Mode**
- **SPI™ Data Interface**
- **Package: TQFP-64 (PAG)**
- **Operating Temperature Range: –40°C to +105°C**

### APPLICATIONS

- **Industrial Power Applications:**
  - Three-Phase Metering
  - Industrial Applications

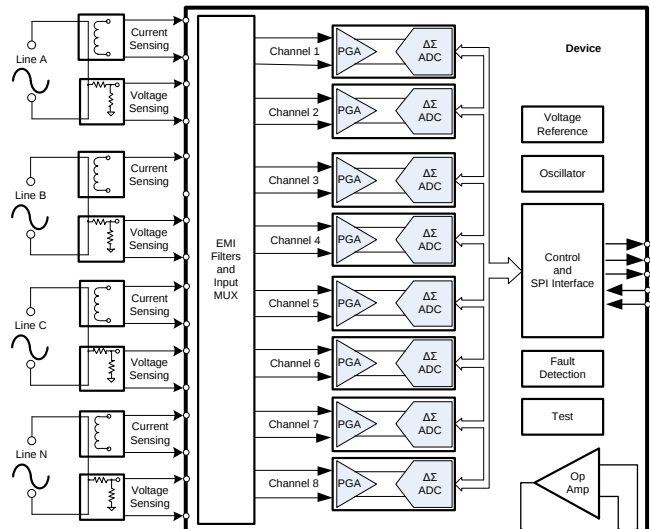
### DESCRIPTION

The ADS130E08 is a multi-channel, simultaneous sampling, 16-bit, delta-sigma ( $\Delta\Sigma$ ) analog-to-digital converter (ADC) with a built-in programmable gain amplifier (PGA), internal reference, and an external oscillator interface.

The device incorporates commonly-required features in industrial metering applications. With high levels of integration and exceptional performance, the ADS130E08 enables the creation of scalable industrial power systems at significantly reduced size, power, and low overall cost.

The ADS130E08 has a flexible input multiplexer per channel that can be independently connected to the internally-generated signals for test, temperature, and fault detection. The ADS130E08 operates at a data rate of 8 kSPS. Fault detection can be implemented internal to the device using the integrated comparators with digital-to-analog converter (DAC)-controlled trigger levels.

Multiple devices can be cascaded in high channel count systems in a daisy-chain configuration. These complete analog front-end (AFE) solutions are packaged in a TQFP-64 package and specified over the industrial temperature range of –40°C to +105°C.



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This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### FAMILY AND ORDERING INFORMATION<sup>(1)</sup>

| PRODUCT   | PACKAGE OPTION | NUMBER OF CHANNELS | ACCURACY  | MAXIMUM SAMPLE RATE (kSPS) | OPERATING TEMPERATURE RANGE |
|-----------|----------------|--------------------|-----------|----------------------------|-----------------------------|
| ADS130E08 | TQFP-64        | 8                  | Class 1.0 | 8                          | –40°C to +105°C             |
| ADS131E04 | TQFP-64        | 4                  | Class 0.1 | 64                         | –40°C to +105°C             |
| ADS131E06 | TQFP-64        | 6                  | Class 0.1 | 64                         | –40°C to +105°C             |
| ADS131E08 | TQFP-64        | 8                  | Class 0.1 | 64                         | –40°C to +105°C             |

- (1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or visit the device product folder at [www.ti.com](http://www.ti.com).

### ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Over operating free-air temperature range, unless otherwise noted.

|                                       |                                                                              | VALUE                    | UNIT |
|---------------------------------------|------------------------------------------------------------------------------|--------------------------|------|
| AVDD to AVSS                          |                                                                              | –0.3 to +5.5             | V    |
| DVDD to DGND                          |                                                                              | –0.3 to +3.9             | V    |
| AVSS to DGND                          |                                                                              | –2.75 to +0.2            | V    |
| V <sub>REF</sub> input to AVSS        |                                                                              | AVSS – 0.3 to AVDD + 0.3 | V    |
| Analog input to AVSS                  |                                                                              | AVSS – 0.3 to AVDD + 0.3 | V    |
| Digital input voltage to DVDD         |                                                                              | –0.3 to DVDD + 0.3       | V    |
| Digital output voltage to DGND        |                                                                              | –0.3 to DVDD + 0.3       | V    |
| Input current                         | Momentary                                                                    | 100                      | mA   |
|                                       | Continuous                                                                   | 10                       | mA   |
| Temperature                           | Operating, T <sub>A</sub>                                                    | –40 to +105              | °C   |
|                                       | Storage, T <sub>stg</sub>                                                    | –60 to +150              | °C   |
|                                       | Maximum junction, T <sub>J</sub>                                             | +150                     | °C   |
| Electrostatic discharge (ESD) ratings | Human body model (HBM)<br>JEDEC standard 22, test method A114-C.01, all pins | ±1000                    | V    |
|                                       | Charged device model (CDM)<br>JEDEC standard 22, test method C101, all pins  | ±500                     | V    |

- (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

## ELECTRICAL CHARACTERISTICS

Minimum and maximum specifications apply from  $-40^{\circ}\text{C}$  to  $+105^{\circ}\text{C}$ . Typical specifications are at  $+25^{\circ}\text{C}$ . All specifications are at  $\text{DVDD} = 1.8\text{ V}$ ,  $\text{AVDD} = 3\text{ V}$ ,  $\text{AVSS} = 0\text{ V}$ ,  $\text{V}_{\text{REF}} = 2.4\text{ V}$ , external  $f_{\text{CLK}} = 2.048\text{ MHz}$ , data rate = 8 kSPS, and gain = 1, unless otherwise noted.

| PARAMETER                            |                                                                              | TEST CONDITIONS                                                                         | ADS130E08                                                                                                              |     |     | UNIT    |
|--------------------------------------|------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------|-----|-----|---------|
|                                      |                                                                              |                                                                                         | MIN                                                                                                                    | TYP | MAX |         |
| ANALOG INPUTS                        |                                                                              |                                                                                         |                                                                                                                        |     |     |         |
|                                      | Full-scale differential input voltage (A <sub>INP</sub> – A <sub>INN</sub> ) |                                                                                         | ±V <sub>REF</sub> / gain                                                                                               |     |     | V       |
|                                      | Input common-mode range                                                      |                                                                                         | See the <a href="#">Input Common-Mode Range</a> subsection of the <a href="#">PGA Settings and Input Range</a> section |     |     |         |
| C <sub>I</sub>                       | Input capacitance                                                            |                                                                                         | 20                                                                                                                     |     |     | pF      |
| I <sub>IB</sub>                      | Input bias current                                                           |                                                                                         | 2                                                                                                                      |     |     | nA      |
|                                      | DC input impedance                                                           |                                                                                         | 500                                                                                                                    |     |     | MΩ      |
| PGA PERFORMANCE                      |                                                                              |                                                                                         |                                                                                                                        |     |     |         |
|                                      | Gain settings                                                                |                                                                                         | 1, 2, 8                                                                                                                |     |     |         |
| BW                                   | Bandwidth                                                                    |                                                                                         | See <a href="#">Table 1</a>                                                                                            |     |     |         |
| ADC PERFORMANCE                      |                                                                              |                                                                                         |                                                                                                                        |     |     |         |
|                                      | Resolution                                                                   | No missing codes                                                                        | 16                                                                                                                     |     |     | Bits    |
| DR                                   | Data rate                                                                    | f <sub>CLK</sub> = 2.048 MHz                                                            | 8                                                                                                                      |     |     | kSPS    |
| CHANNEL PERFORMANCE (DC Performance) |                                                                              |                                                                                         |                                                                                                                        |     |     |         |
|                                      | Dynamic range                                                                | G = 1                                                                                   | 86                                                                                                                     | 89  |     | dB      |
|                                      |                                                                              | G = 2 and 8                                                                             |                                                                                                                        | 89  |     | dB      |
| INL                                  | Integral nonlinearity                                                        | Full-scale with gain = 1, best fit                                                      | 3                                                                                                                      |     |     | ppm     |
| E <sub>O</sub>                       | Offset error                                                                 |                                                                                         | ±350                                                                                                                   |     |     | μV      |
|                                      | Offset error drift                                                           |                                                                                         | 0.6                                                                                                                    |     |     | μV/°C   |
| E <sub>G</sub>                       | Gain error                                                                   | Excluding voltage reference error                                                       | ±0.1                                                                                                                   |     |     | % of FS |
|                                      | Gain drift                                                                   | Excluding voltage reference drift                                                       | 3                                                                                                                      |     |     | ppm/°C  |
|                                      | Gain match between channels                                                  |                                                                                         | 0.2                                                                                                                    |     |     | % of FS |
| CHANNEL PERFORMANCE (AC Performance) |                                                                              |                                                                                         |                                                                                                                        |     |     |         |
| CMRR                                 | Common-mode rejection ratio                                                  | f <sub>CM</sub> = 50 Hz and 60 Hz <sup>(1)</sup>                                        | –110                                                                                                                   |     |     | dB      |
| PSRR                                 | Power-supply rejection ratio                                                 | f <sub>PS</sub> = 50 Hz and 60 Hz                                                       | 80                                                                                                                     |     |     | dB      |
|                                      | Crosstalk                                                                    | f <sub>IN</sub> = 50 Hz and 60 Hz                                                       | –105                                                                                                                   |     |     | dB      |
|                                      | Accuracy                                                                     | 1:3000 dynamic range with a 1-second measurement (V <sub>RMS</sub> / I <sub>RMS</sub> ) | 0.5                                                                                                                    |     |     | %       |
| SNR                                  | Signal-to-noise ratio                                                        | f <sub>IN</sub> = 10-Hz input, –0.5 dBFs                                                | 89                                                                                                                     |     |     | dB      |
| THD                                  | Total harmonic distortion                                                    | 10 Hz, –0.5 dBFs                                                                        | –108                                                                                                                   |     |     | dB      |
| OPEN-CIRCUIT DETECT AND ALARM        |                                                                              |                                                                                         |                                                                                                                        |     |     |         |
|                                      | Comparator threshold accuracy                                                |                                                                                         | ±30                                                                                                                    |     |     | mV      |
| EXTERNAL REFERENCE                   |                                                                              |                                                                                         |                                                                                                                        |     |     |         |
| V <sub>I(ref)</sub>                  | Reference input voltage                                                      | AVDD = 3 V, V <sub>REF</sub> = (V <sub>REFP</sub> – V <sub>REFN</sub> )                 | 2.5                                                                                                                    |     |     | V       |
|                                      |                                                                              | AVDD = 5 V, V <sub>REF</sub> = (V <sub>REFP</sub> – V <sub>REFN</sub> )                 | 4                                                                                                                      |     |     | V       |
| V <sub>REFN</sub>                    | Negative input                                                               |                                                                                         | AVSS                                                                                                                   |     |     | V       |
| V <sub>REFP</sub>                    | Positive input                                                               |                                                                                         | AVSS + 2.5                                                                                                             |     |     | V       |
|                                      | Input impedance                                                              |                                                                                         | 10                                                                                                                     |     |     | kΩ      |

- (1) CMRR is measured with a common-mode signal of  $(\text{AVSS} + 0.3\text{ V})$  to  $(\text{AVDD} - 0.3\text{ V})$ . The values indicated are the minimum of the eight channels.

## ELECTRICAL CHARACTERISTICS (continued)

Minimum and maximum specifications apply from  $-40^{\circ}\text{C}$  to  $+105^{\circ}\text{C}$ . Typical specifications are at  $+25^{\circ}\text{C}$ . All specifications are at  $\text{DVDD} = 1.8\text{ V}$ ,  $\text{AVDD} = 3\text{ V}$ ,  $\text{AVSS} = 0\text{ V}$ ,  $\text{V}_{\text{REF}} = 2.4\text{ V}$ , external  $f_{\text{CLK}} = 2.048\text{ MHz}$ , data rate = 8 KSPS, and gain = 1, unless otherwise noted.

| PARAMETER                                        |                             |                        | TEST CONDITIONS                                       | ADS130E08                 |            |                                | UNIT                         |
|--------------------------------------------------|-----------------------------|------------------------|-------------------------------------------------------|---------------------------|------------|--------------------------------|------------------------------|
|                                                  |                             |                        |                                                       | MIN                       | TYP        | MAX                            |                              |
| OPERATIONAL AMPLIFIER                            |                             |                        |                                                       |                           |            |                                |                              |
| Integrated noise                                 |                             |                        | 0.1 Hz to 100 Hz                                      | 7                         |            |                                | $\mu\text{V}_{\text{RMS}}$   |
| Noise density                                    |                             |                        | 2 kHz                                                 | 120                       |            |                                | $\text{nV}/\sqrt{\text{Hz}}$ |
| GBP                                              | Gain bandwidth product      |                        | 50 k $\Omega$    10-pF load                           | 100                       |            |                                | kHz                          |
| SR                                               | Slew rate                   |                        | 50 k $\Omega$    10-pF load                           | 0.25                      |            |                                | V/ $\mu\text{s}$             |
| Load current                                     |                             |                        |                                                       | 50                        |            |                                | $\mu\text{A}$                |
| THD                                              | Total harmonic distortion   |                        | $f_{\text{IN}} = 100\text{ Hz}$                       | 70                        |            |                                | dB                           |
| CMIR Common-mode input range                     |                             |                        |                                                       | AVSS + 0.7                | AVSS – 0.3 |                                | V                            |
| Quiescent power consumption                      |                             |                        |                                                       | 20                        |            |                                | $\mu\text{A}$                |
| INTERNAL REFERENCE                               |                             |                        |                                                       |                           |            |                                |                              |
| V <sub>O</sub>                                   | Output voltage              |                        | CONFIG3.VREF_4V = 0                                   | 2.4                       |            |                                | V                            |
|                                                  |                             |                        | CONFIG3.VREF_4V = 1                                   | 4                         |            |                                | V                            |
| V <sub>REF</sub> accuracy                        |                             |                        |                                                       | $\pm 0.2$                 |            |                                | %                            |
| Drift                                            |                             |                        | –40°C to +105°C                                       | 45                        |            |                                | ppm/°C                       |
| Start-up time                                    |                             |                        | Settled to 0.2%                                       | 150                       |            |                                | ms                           |
| SYSTEM MONITORS                                  |                             |                        |                                                       |                           |            |                                |                              |
| Analog supply reading error                      |                             |                        |                                                       | 2                         |            |                                | %                            |
| Digital supply reading error                     |                             |                        |                                                       | 2                         |            |                                | %                            |
| Device wake up                                   |                             |                        | From power-up to $\overline{\text{DRDY}}$ low         | 150                       |            |                                | ms                           |
|                                                  |                             |                        | STANDBY mode                                          | 125                       |            |                                | $\mu\text{s}$                |
| Temperature sensor reading                       | Voltage                     | T <sub>A</sub> = +25°C | 145                                                   |                           |            | mV                             |                              |
|                                                  | Coefficient                 |                        | 490                                                   |                           |            | $\mu\text{V}/^{\circ}\text{C}$ |                              |
| TEST SIGNAL                                      |                             |                        |                                                       |                           |            |                                |                              |
| Signal frequency                                 |                             |                        | See <a href="#">Register Map</a> section for settings | $f_{\text{CLK}} / 2^{21}$ |            |                                | Hz                           |
|                                                  |                             |                        |                                                       | $f_{\text{CLK}} / 2^{20}$ |            |                                | Hz                           |
| Signal voltage                                   |                             |                        | See <a href="#">Register Map</a> section for settings | $\pm 1$                   |            |                                | mV                           |
|                                                  |                             |                        |                                                       | $\pm 2$                   |            |                                | mV                           |
| Accuracy                                         |                             |                        |                                                       | $\pm 2$                   |            |                                | %                            |
| CLOCK                                            |                             |                        |                                                       |                           |            |                                |                              |
| Internal oscillator clock frequency              |                             |                        | Nominal frequency                                     | 2.048                     |            |                                | MHz                          |
|                                                  |                             |                        | T <sub>A</sub> = +25°C                                | $\pm 0.5$                 |            |                                | %                            |
|                                                  |                             |                        | –40°C $\leq$ T <sub>A</sub> $\leq$ +105°C             | $\pm 2.5$                 |            |                                | %                            |
| Internal oscillator start-up time                |                             |                        |                                                       | 20                        |            |                                | $\mu\text{s}$                |
| Internal oscillator power consumption            |                             |                        |                                                       | 120                       |            |                                | $\mu\text{W}$                |
| External clock input frequency                   |                             |                        | CLKSEL pin = 0                                        | 0.7                       | 2.048      | 2.25                           | MHz                          |
| DIGITAL INPUT AND OUTPUT (DVDD = 1.8 V to 3.6 V) |                             |                        |                                                       |                           |            |                                |                              |
| V <sub>IH</sub>                                  | Logic level, input voltage  | High                   |                                                       | 0.8 DVDD                  | DVDD + 0.1 |                                | V                            |
| V <sub>IL</sub>                                  |                             | Low                    |                                                       | –0.1                      | 0.2 DVDD   |                                | V                            |
| V <sub>OH</sub>                                  | Logic level, output voltage | High                   | I <sub>OH</sub> = –500 $\mu\text{A}$                  | 0.9 DVDD                  |            |                                | V                            |
| V <sub>OL</sub>                                  |                             | Low                    | I <sub>OL</sub> = +500 $\mu\text{A}$                  | 0.1 DVDD                  |            |                                | V                            |
| I <sub>IN</sub>                                  | Input current               |                        | 0 V < V <sub>DigitalInput</sub> < DVDD                | –10                       | +10        |                                | $\mu\text{A}$                |

## ELECTRICAL CHARACTERISTICS (continued)

Minimum and maximum specifications apply from –40°C to +105°C. Typical specifications are at +25°C. All specifications are at DVDD = 1.8 V, AVDD = 3 V, AVSS = 0 V, V<sub>REF</sub> = 2.4 V, external f<sub>CLK</sub> = 2.048 MHz, data rate = 8 KSPS, and gain = 1, unless otherwise noted.

| PARAMETER                                            |                  |                   | TEST CONDITIONS | ADS130E08 |      |      | UNIT |
|------------------------------------------------------|------------------|-------------------|-----------------|-----------|------|------|------|
|                                                      |                  |                   |                 | MIN       | TYP  | MAX  |      |
| POWER-SUPPLY REQUIREMENTS                            |                  |                   |                 |           |      |      |      |
| AVDD                                                 | Analog supply    | AVDD – AVSS       |                 | 2.7       | 3    | 5.25 | V    |
| DVDD                                                 | Digital supply   |                   |                 | 1.7       | 1.8  | 3.6  | V    |
| AVDD – DVDD                                          |                  |                   |                 | –2.1      |      | 3.6  | V    |
| SUPPLY CURRENT (Operational Amplifier Turned Off)    |                  |                   |                 |           |      |      |      |
| I <sub>AVDD</sub>                                    | Normal operation | AVDD – AVSS = 3 V |                 | 1.8       |      |      | mA   |
|                                                      |                  | AVDD – AVSS = 5 V |                 | 2.2       |      |      | mA   |
| I <sub>DVDD</sub>                                    |                  | DVDD = 3.3 V      |                 | 0.5       |      |      | mA   |
|                                                      |                  | DVDD = 1.8 V      |                 | 0.3       |      |      | mA   |
| POWER DISSIPATION                                    |                  |                   |                 |           |      |      |      |
| Quiescent power dissipation<br>(analog supply = 3 V) |                  |                   | Normal mode     |           | 6    | 6.6  | mW   |
|                                                      |                  |                   | Power-down mode |           | 10   |      | μW   |
|                                                      |                  |                   | Standby mode    |           | 2    |      | mW   |
| Quiescent power dissipation<br>(analog supply = 5 V) |                  |                   | Normal mode     |           | 11.5 |      | mW   |
|                                                      |                  |                   | Power-down mode |           | 20   |      | μW   |
|                                                      |                  |                   | Standby mode    |           | 4    |      | mW   |
| TEMPERATURE                                          |                  |                   |                 |           |      |      |      |
| Temperature range                                    | Specified        |                   |                 | –40       |      | +105 | °C   |
|                                                      | Operating        |                   |                 | –40       |      | +105 | °C   |
|                                                      | Storage          |                   |                 | –60       |      | +150 | °C   |

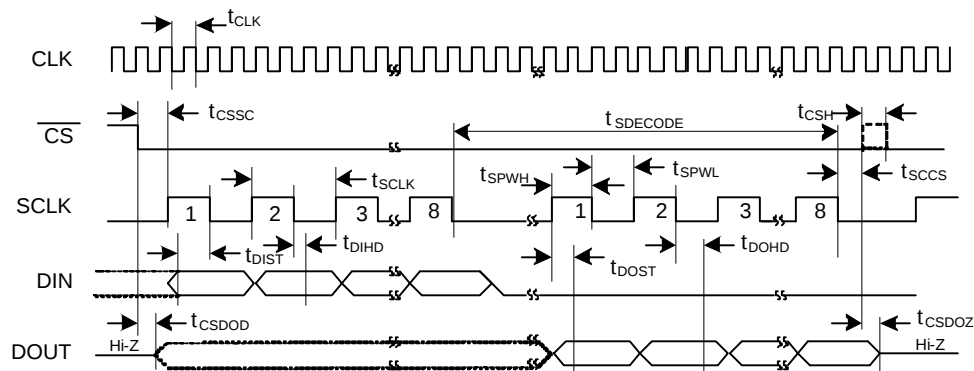
## THERMAL INFORMATION

| THERMAL METRIC <sup>(1)</sup> |                                              | ADS130E08  | UNITS |
|-------------------------------|----------------------------------------------|------------|-------|
|                               |                                              | PAG (TQFP) |       |
|                               |                                              | 64 PINS    |       |
| θ <sub>JA</sub>               | Junction-to-ambient thermal resistance       | 35         | °C/W  |
| θ <sub>JCTop</sub>            | Junction-to-case (top) thermal resistance    | 31         |       |
| θ <sub>JB</sub>               | Junction-to-board thermal resistance         | 26         |       |
| ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 0.1        |       |
| ψ <sub>JB</sub>               | Junction-to-board characterization parameter | NA         |       |
| θ <sub>JCbot</sub>            | Junction-to-case (bottom) thermal resistance | NA         |       |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

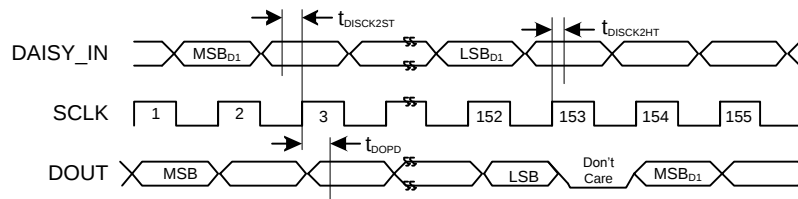
## PARAMETER MEASUREMENT INFORMATION

### TIMING CHARACTERISTICS



NOTE: SPI settings are CPOL = 0 and CPHA = 1.

**Figure 1. Serial Interface Timing**



**Figure 2. Daisy-Chain Interface Timing**

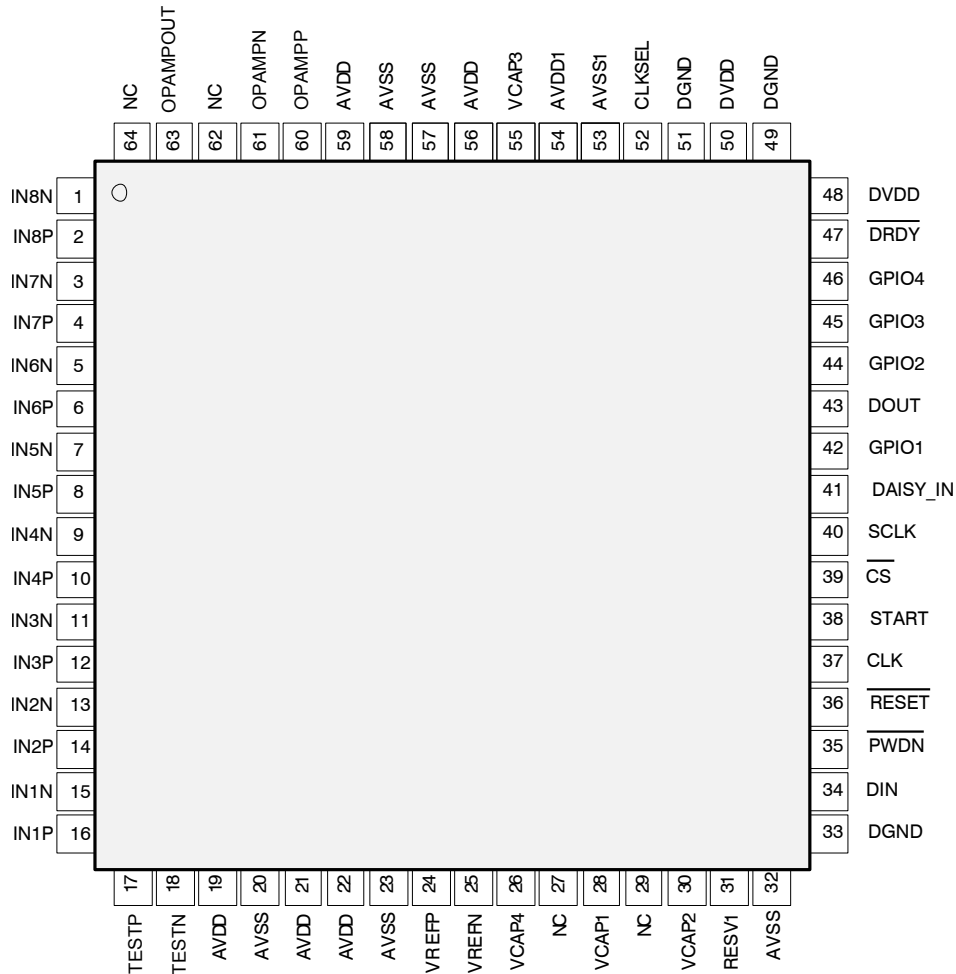
**Timing Requirements For Figure 1 and Figure 2<sup>(1)</sup>**

| PARAMETER             | DESCRIPTION                                      | 2.7 V ≤ DVDD ≤ 3.6 V |     | 1.7 V ≤ DVDD ≤ 2.0 V |     | UNIT              |
|-----------------------|--------------------------------------------------|----------------------|-----|----------------------|-----|-------------------|
|                       |                                                  | MIN                  | MAX | MIN                  | MAX |                   |
| t <sub>CLK</sub>      | Master clock period                              | 414                  | 514 | 414                  | 514 | ns                |
| t <sub>CSSC</sub>     | $\overline{CS}$ low to first SCLK: setup time    | 6                    |     | 17                   |     | ns                |
| t <sub>SCLK</sub>     | SCLK period                                      | 50                   |     | 66.6                 |     | ns                |
| t <sub>SPWH, L</sub>  | SCLK pulse width, high and low                   | 15                   |     | 25                   |     | ns                |
| t <sub>DIST</sub>     | DIN valid to SCLK falling edge: setup time       | 10                   |     | 10                   |     | ns                |
| t <sub>DIHD</sub>     | Valid DIN after SCLK falling edge: hold time     | 10                   |     | 11                   |     | ns                |
| t <sub>DOHD</sub>     | SCLK falling edge to invalid DOUT: hold time     | 10                   |     | 10                   |     | ns                |
| t <sub>DOST</sub>     | SCLK rising edge to DOUT valid: setup time       |                      | 17  |                      | 32  | ns                |
| t <sub>CSH</sub>      | $\overline{CS}$ high pulse                       | 2                    |     | 2                    |     | t <sub>CLKs</sub> |
| t <sub>CSDOD</sub>    | $\overline{CS}$ low to DOUT driven               | 10                   |     | 20                   |     | ns                |
| t <sub>SCCS</sub>     | Eighth SCLK falling edge to $\overline{CS}$ high | 4                    |     | 4                    |     | t <sub>CLKs</sub> |
| t <sub>SDECODE</sub>  | Command decode time                              | 4                    |     | 4                    |     | t <sub>CLKs</sub> |
| t <sub>CSDOZ</sub>    | $\overline{CS}$ high to DOUT Hi-Z                |                      | 10  |                      | 20  | ns                |
| t <sub>DISCK2ST</sub> | Valid DAISY_IN to SCLK rising edge: setup time   | 10                   |     | 10                   |     | ns                |
| t <sub>DISCK2HT</sub> | Valid DAISY_IN after SCLK rising edge: hold time | 10                   |     | 10                   |     | ns                |

(1) Specifications apply from –40°C to +105°C. Load on DOUT = 20 pF || 100 kΩ, unless otherwise noted.

## PIN CONFIGURATION

### PAG PACKAGE TQFP-64 (TOP VIEW)



### PIN ASSIGNMENTS

| NAME              | TERMINAL           | FUNCTION             | DESCRIPTION                      |
|-------------------|--------------------|----------------------|----------------------------------|
| AVDD              | 19, 21, 22, 56, 59 | Supply               | Analog supply                    |
| AVDD1             | 54                 | Supply               | Charge pump analog supply        |
| AVSS              | 20, 23, 32, 57, 58 | Supply               | Analog ground                    |
| AVSS1             | 53                 | Supply               | Charge pump analog ground        |
| CLK               | 37                 | Digital input        | Master clock input               |
| CLKSEL            | 52                 | Digital input        | Master clock select              |
| $\overline{CS}$   | 39                 | Digital input        | SPI chip select; active low      |
| DAISY_IN          | 41                 | Digital input        | Daisy-chain input                |
| DGND              | 33, 49, 51         | Supply               | Digital ground                   |
| DIN               | 34                 | Digital input        | SPI data in                      |
| DOUT              | 43                 | Digital output       | SPI data out                     |
| $\overline{DRDY}$ | 47                 | Digital output       | Data ready; active low           |
| DVDD              | 48, 50             | Supply               | Digital power supply             |
| GPIO1             | 42                 | Digital input/output | General-purpose input/output pin |

**PIN ASSIGNMENTS (continued)**

| NAME                      | TERMINAL       | FUNCTION                | DESCRIPTION                                           |
|---------------------------|----------------|-------------------------|-------------------------------------------------------|
| GPIO2                     | 44             | Digital input/output    | General-purpose input/output pin                      |
| GPIO3                     | 45             | Digital input/output    | General-purpose input/output pin                      |
| GPIO4                     | 46             | Digital input/output    | General-purpose input/output pin                      |
| IN1N <sup>(1)</sup>       | 15             | Analog input            | Differential analog negative input 1                  |
| IN1P                      | 16             | Analog input            | Differential analog positive input 1                  |
| IN2N                      | 13             | Analog input            | Differential analog negative input 2                  |
| IN2P                      | 14             | Analog input            | Differential analog positive input 2                  |
| IN3N                      | 11             | Analog input            | Differential analog negative input 3                  |
| IN3P                      | 12             | Analog input            | Differential analog positive input 3                  |
| IN4N                      | 9              | Analog input            | Differential analog negative input 4                  |
| IN4P                      | 10             | Analog input            | Differential analog positive input 4                  |
| IN5N                      | 7              | Analog input            | Differential analog negative input 5                  |
| IN5P                      | 8              | Analog input            | Differential analog positive input 5                  |
| IN6N                      | 5              | Analog input            | Differential analog negative input 6                  |
| IN6P                      | 6              | Analog input            | Differential analog positive input 6                  |
| IN7N                      | 3              | Analog input            | Differential analog negative input 7                  |
| IN7P                      | 4              | Analog input            | Differential analog positive input 7                  |
| IN8N                      | 1              | Analog input            | Differential analog negative input 8                  |
| IN8P                      | 2              | Analog input            | Differential analog positive input 8                  |
| NC                        | 27, 29, 62, 64 | —                       | No connection, leave floating                         |
| OPAMPN                    | 61             | Analog                  | Op amp inverting input                                |
| OPAMPOUT                  | 63             | Analog                  | Op amp output                                         |
| OPAMPP                    | 60             | —                       | Op amp noninverting input                             |
| $\overline{\text{PWDN}}$  | 35             | Digital input           | Power-down; active low                                |
| $\overline{\text{RESET}}$ | 36             | Digital input           | System reset; active low                              |
| RESV1                     | 31             | Digital input           | Reserved for future use; must tie to logic low (DGND) |
| SCLK                      | 40             | Digital input           | SPI clock                                             |
| START                     | 38             | Digital input           | Start conversion                                      |
| TESTN <sup>(2)</sup>      | 18             | Analog output           | Internal test signal                                  |
| TESTP                     | 17             | Analog output           | Internal test signal                                  |
| VCAP1                     | 28             | Analog input and output | Analog bypass capacitor                               |
| VCAP2                     | 30             | —                       | Analog bypass capacitor                               |
| VCAP3                     | 55             | —                       | Analog bypass capacitor                               |
| VCAP4                     | 26             | Analog output           | Analog bypass capacitor                               |
| VREFN                     | 25             | Analog input            | Negative reference voltage                            |
| VREFP                     | 24             | Analog input and output | Positive reference voltage                            |

(1) Connect unused IN1x to IN8x terminals to AVDD.

(2) Connect unused TESTx terminals to AVDD.

## TYPICAL CHARACTERISTICS

All plots are at  $T_A = +25^\circ\text{C}$ ,  $AVDD = 3\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 1.8\text{ V}$ , internal  $VREFP = 2.4\text{ V}$ ,  $VREFN = AVSS$ , external clock = 2.048 MHz, data rate = 8 kSPS, and gain = 1, unless otherwise noted.

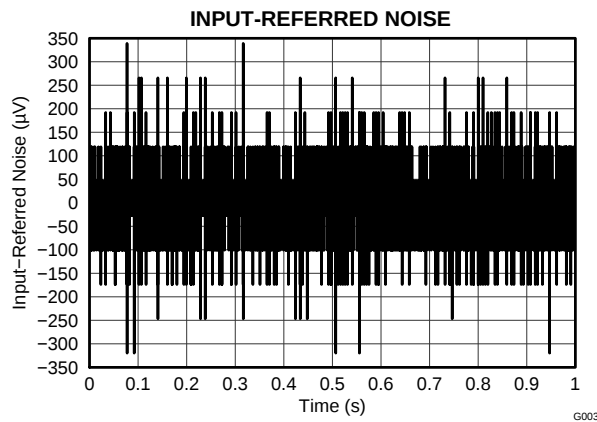


Figure 3.

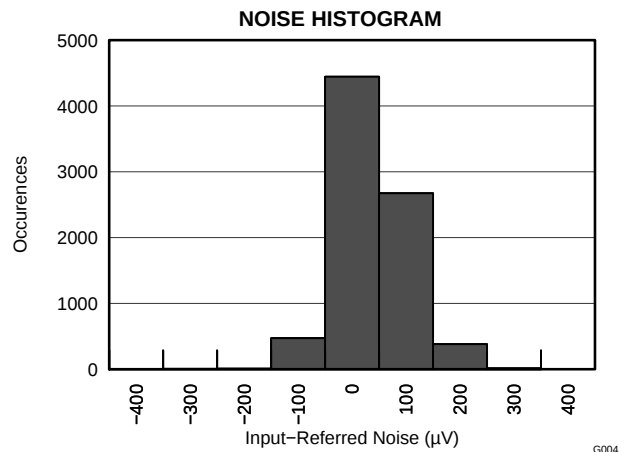


Figure 4.

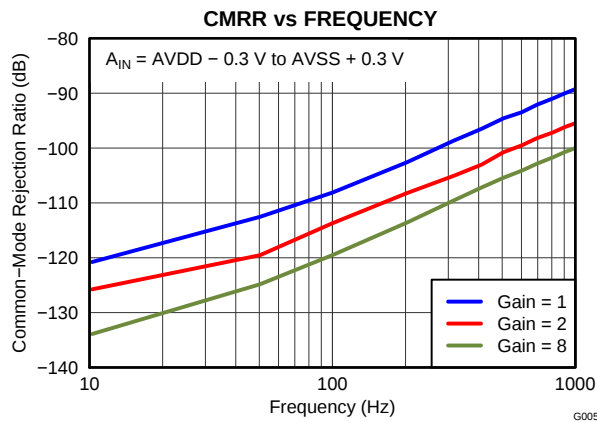


Figure 5.

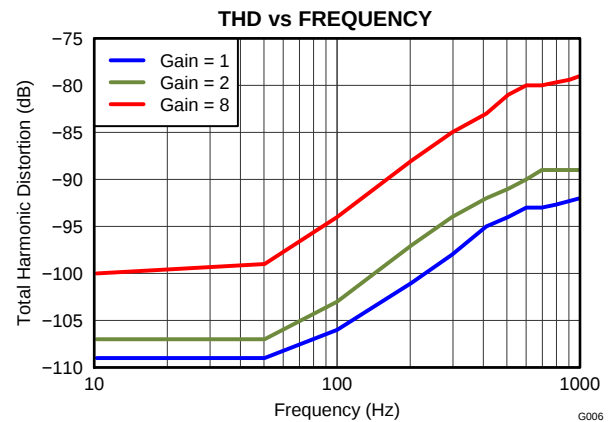


Figure 6.

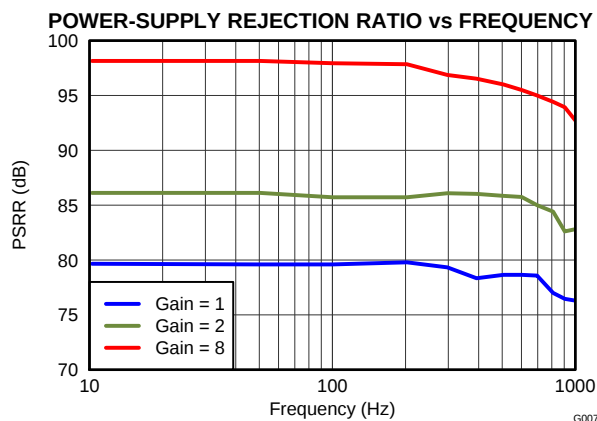


Figure 7.

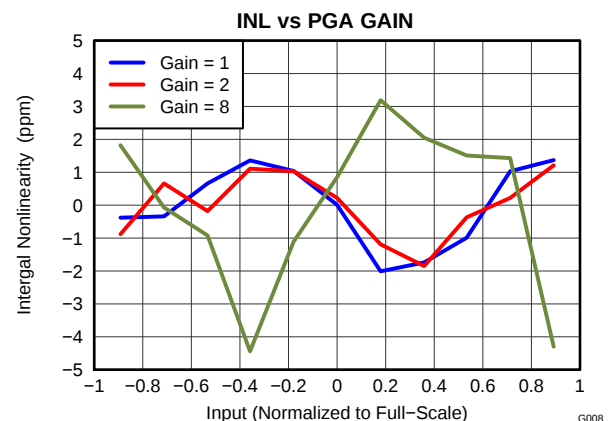


Figure 8.

## TYPICAL CHARACTERISTICS (continued)

All plots are at  $T_A = +25^\circ\text{C}$ ,  $AVDD = 3\text{ V}$ ,  $AVSS = 0\text{ V}$ ,  $DVDD = 1.8\text{ V}$ , internal  $VREFP = 2.4\text{ V}$ ,  $VREFN = AVSS$ , external clock = 2.048 MHz, data rate = 8 kSPS, and gain = 1, unless otherwise noted.

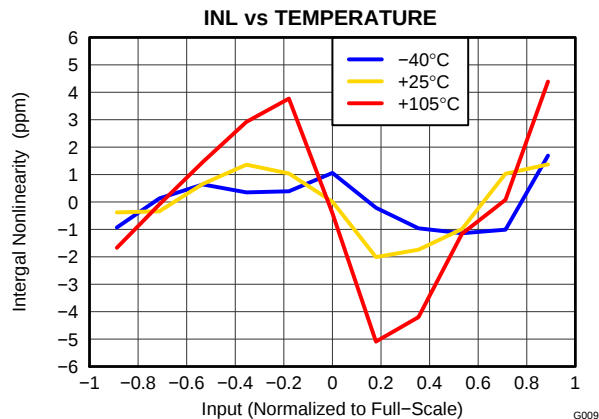


Figure 9.

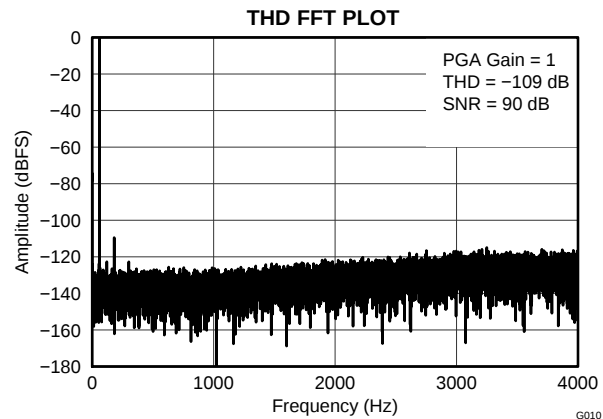


Figure 10.

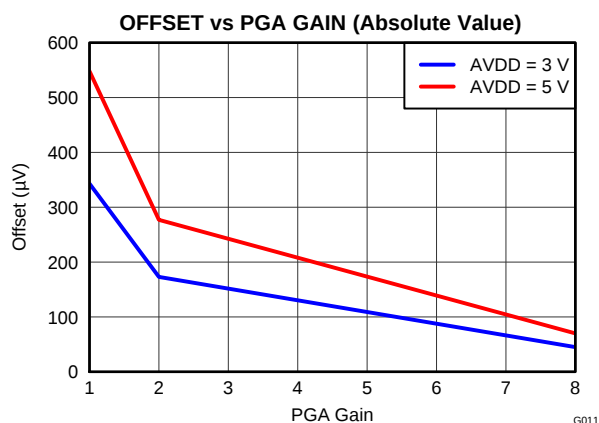


Figure 11.

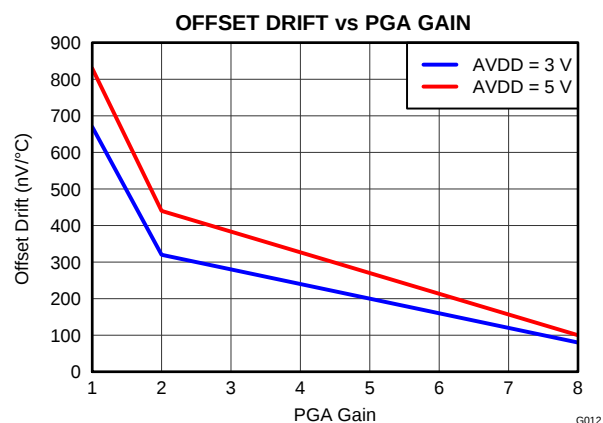


Figure 12.

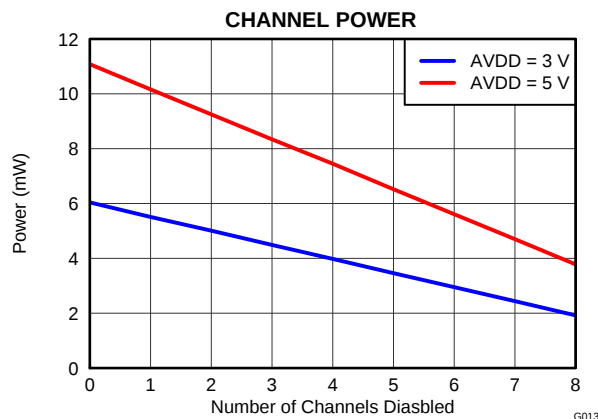


Figure 13.

## OVERVIEW

The ADS130E08 is a low-power, multichannel, simultaneously-sampling, 16-bit, delta-sigma ( $\Delta\Sigma$ ) analog-to-digital converter (ADC) with an integrated programmable gain amplifier (PGA). This functionality make the ADS130E08 suitable for industrial power-metering applications.

The ADS130E08 has a highly-programmable multiplexer that allows for temperature, supply, and input short measurements. PGA gain can be chosen from one of three settings (1, 2, and 8). The ADCs in the device offer a data rate of 8 kSPS. Communication to the device is accomplished using an SPI-compatible interface. The device provides four general-purpose IO (GPIO) pins for general use. Multiple devices can be synchronized using the START pin.

The internal reference can be programmed to either 2.4 V or 4 V. Fault detection can be accomplished by using the integrated comparators, with programmable trigger-point settings. A detailed diagram of the ADS130E08 is shown in [Figure 14](#).

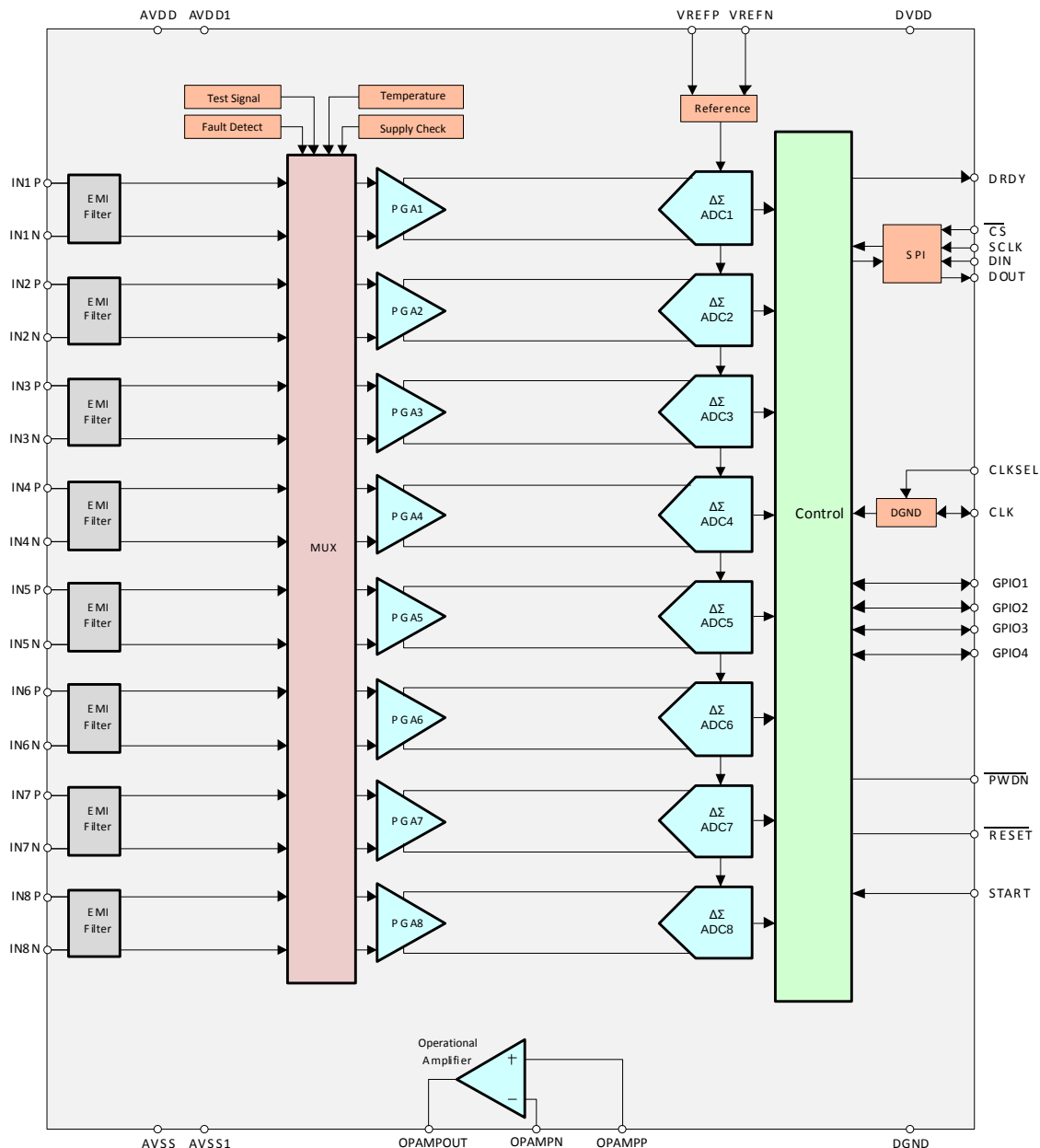


Figure 14. Functional Block Diagram

## THEORY OF OPERATION

This section contains details of the ADS130E08 internal functional elements. The analog blocks are discussed first, followed by the digital interface. Blocks implementing power-specific functions are covered towards the end of this document.

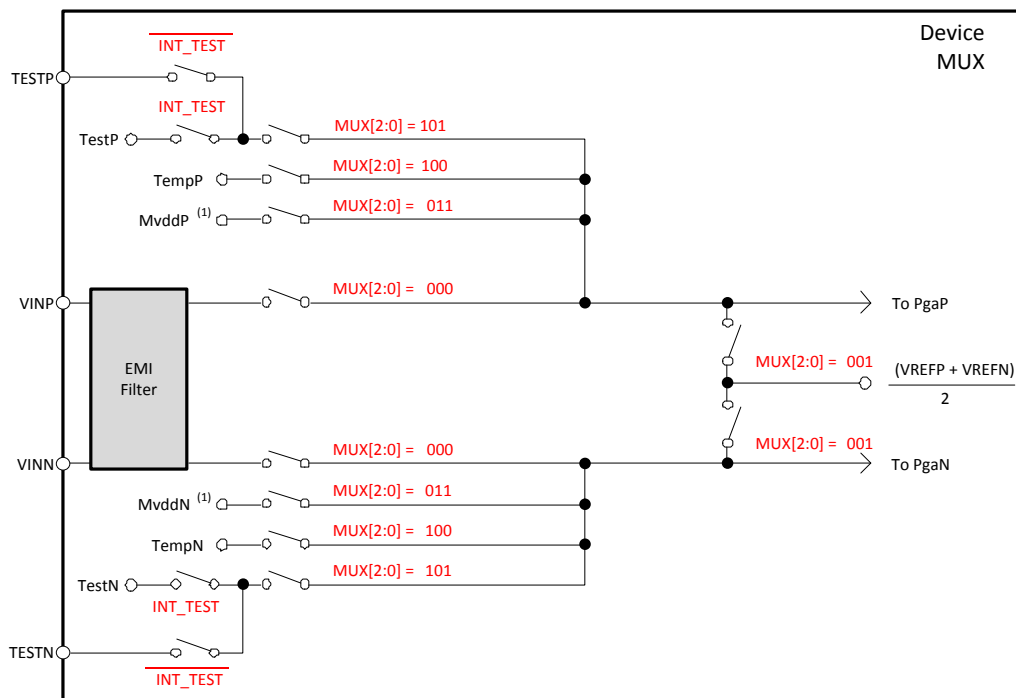
Throughout this document,  $f_{CLK}$  denotes the CLK pin signal frequency,  $t_{CLK}$  denotes the CLK pin signal period,  $f_{DR}$  denotes the output data rate,  $t_{DR}$  denotes the output data time period, and  $f_{MOD}$  denotes the frequency at which the modulator samples the input.

### EMI FILTER

An RC filter at the input acts as an electromagnetic interference (EMI) filter on all channels. The –3-dB filter bandwidth is approximately 3 MHz.

### INPUT MULTIPLEXER

The ADS130E08 input multiplexers are very flexible and provide many configurable signal-switching options. Figure 15 shows a diagram of the multiplexer on a single channel of the device. VINP and VINN are separate for each of the eight blocks. This flexibility allows for significant device and sub-system diagnostics, calibration, and configuration. Switch settings for each channel are selected by writing the appropriate values to the CHnSET register (see the [CHnSET: Individual Channel Settings \(n = 1 to 8\)](#) Register in the [Register Map](#) section for details.)



(1) MVDD monitor voltage supply depends on channel number; see the [Supply Measurements \(MVDDP, MVDDN\)](#) section.

**Figure 15. Input Multiplexer Block for One Channel**

## Device Noise Measurements

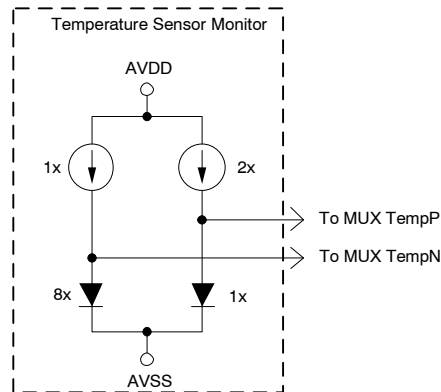
Setting CHnSET[2:0] = 001 sets the common-mode voltage of  $[(VREFP + VREFN) / 2]$  to both inputs of the channel. This setting can be used to test inherent device noise in the user system.

## Test Signals (TestP and TestN)

Setting CHnSET[2:0] = 101 provides internally-generated test signals for use in sub-system verification at power-up. Test signals are controlled through register settings (see the [CONFIG2: Configuration Register 2](#) subsection in the [Register Map](#) section for details). TEST\_AMP controls the signal amplitude and TEST\_FREQ controls the switching at the required frequency. The test signals are multiplexed and transmitted out of the device at the TESTP and TESTN pins. A bit register (CONFIG2.INT\_TEST = 0) deactivates the internal test signals so that the test signal can be driven externally. This feature allows the calibration of multiple devices with the same signal.

## Temperature Sensor (TempP, TempN)

The ADS130E08 contains an on-chip temperature sensor. This sensor uses two internal diodes with one diode having a current density 16x that of the other, as shown in [Figure 16](#). The difference in diode current densities yields a difference in voltage that is proportional to absolute temperature.



**Figure 16. Temperature Sensor Measurement in the Input**

As a result of the low thermal resistance of the package to the printed circuit board (PCB), the internal device temperature tracks the PCB temperature closely. Note that self-heating of the ADS130E08 causes a higher reading than the temperature of the surrounding PCB.

The scale factor of [Equation 1](#) converts the temperature reading to degrees Celsius. Before using this equation, the temperature reading code must first be scaled to microvolts.

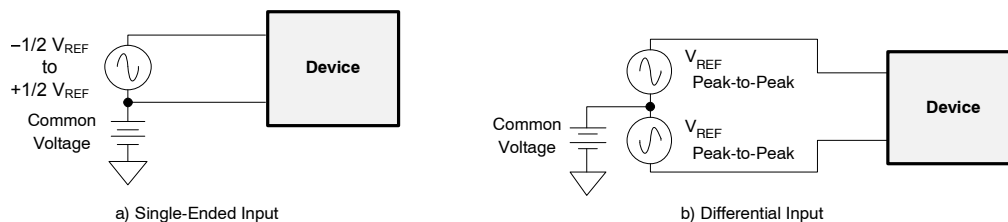
$$\text{Temperature (}^{\circ}\text{C)} = \left[ \frac{\text{Temperature Reading (}\mu\text{V)} - 168,000 \mu\text{V}}{394 \mu\text{V}/^{\circ}\text{C}} \right] + 25^{\circ}\text{C} \quad (1)$$

## Supply Measurements (MVDDP, MVDDN)

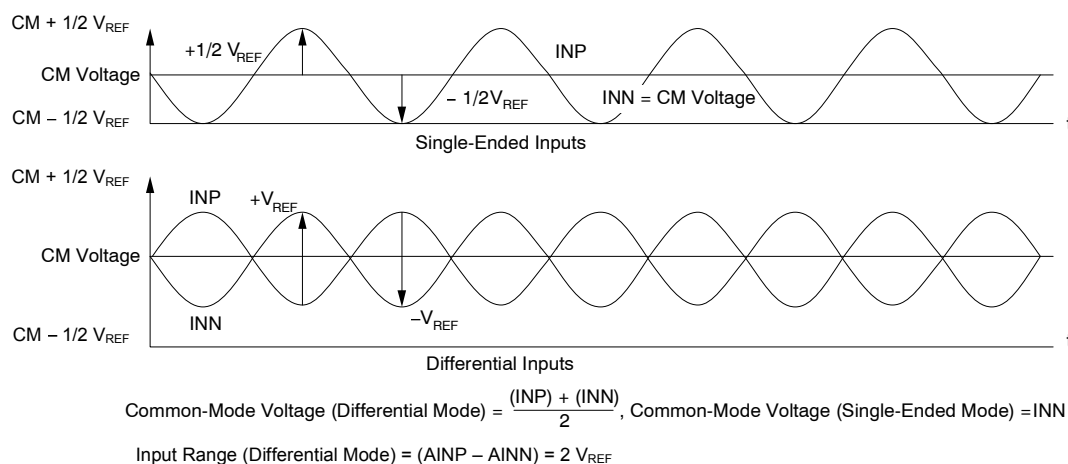
Setting CHnSET[2:0] = 011 sets the channel inputs to different supply voltages of the device. For channels 1, 2, 5, 6, 7, and 8, (MVDDP – MVDDN) is  $[0.5(AVDD - AVSS)]$ ; for channels 3 and 4, (MVDDP – MVDDN) is DVDD / 4. Note that to avoid saturating the PGA while measuring power supplies, the gain must be set to '1'.

## ANALOG INPUT

The ADS130E08 analog input is fully differential. Assuming  $PGA = 1$ , the input ( $INP - INN$ ) can span between  $-V_{REF}$  to  $+V_{REF}$ . Refer to [Table 3](#) for an explanation of the correlation between the analog input and the digital codes. There are two general methods of driving the ADS130E08 analog input: single-ended or differential, as shown in [Figure 17](#) and [Figure 18](#). Note that  $INP$  and  $INN$  are 180° out-of-phase in the differential input method. When the input is single-ended, the  $INN$  input is held at the common-mode voltage, preferably at mid-supply. The  $INP$  input swings around the same common voltage and the peak-to-peak amplitude is (common-mode +  $1/2 V_{REF}$ ) and (common-mode -  $1/2 V_{REF}$ ). When the input is differential, the common-mode is given by  $(INP + INN) / 2$ . Both  $INP$  and  $INN$  inputs swing from (common-mode +  $1/2 V_{REF}$ ) to (common-mode -  $1/2 V_{REF}$ ). For optimal performance, it is recommended that the ADS130E08 be used in a differential configuration.



**Figure 17. Methods of Driving the ADS130E08: Single-Ended or Differential**

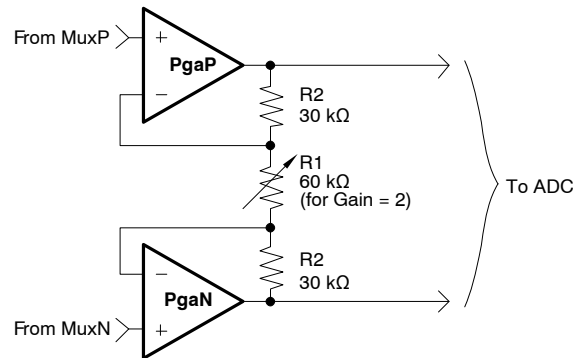


**Figure 18. Using the ADS130E08 in Single-Ended and Differential Input Modes**

## PGA SETTINGS AND INPUT RANGE

The PGA is a differential input and output amplifier, as shown in [Figure 19](#). The PGA has three gain settings (1, 2, and 8) that can be set by writing to the CHnSET register (see the [CHnSET: Individual Channel Settings \(n = 1 to 8\)](#) Register in the [Register Map](#) section for details). The ADS130E08 has CMOS inputs and, therefore, has negligible current noise. [Table 1](#) shows the typical bandwidth values for various gain settings. Note that [Table 1](#) only shows small-signal bandwidth. For large signals, performance is limited by PGA slew rate.

The PGA resistor string that implements the gain has 120 kΩ of resistance. This resistance provides a current path across the PGA outputs in the presence of a differential input signal. This current is in addition to the quiescent current specified for the device in the presence of a differential signal at the input.



**Figure 19. PGA Implementation**

**Table 1. PGA Gain versus Bandwidth**

| GAIN | NOMINAL BANDWIDTH AT ROOM TEMPERATURE (kHz) |
|------|---------------------------------------------|
| 1    | 237                                         |
| 2    | 146                                         |
| 8    | 48                                          |

### Input Common-Mode Range

The usable input common-mode range of the analog front-end depends on various parameters, including the maximum differential input signal, supply voltage, and PGA gain. Equation 2 describes this range.

$$AVDD - 0.2 - \left[ \frac{\text{Gain } V_{\text{MAX\_DIFF}}}{2} \right] > \text{CM} > AVSS + 0.2 + \left[ \frac{\text{Gain } V_{\text{MAX\_DIFF}}}{2} \right]$$

where:

$V_{\text{MAX\_DIFF}}$  = maximum differential signal at the PGA input

CM = common-mode range

(2)

For example:

If  $V_{\text{DD}} = 3.3 \text{ V}$ , gain = 2, and  $V_{\text{MAX\_DIFF}} = 1000 \text{ mV}$ ,

Then  $1.2 \text{ V} < \text{CM} < 2.1 \text{ V}$

### Input Differential Dynamic Range

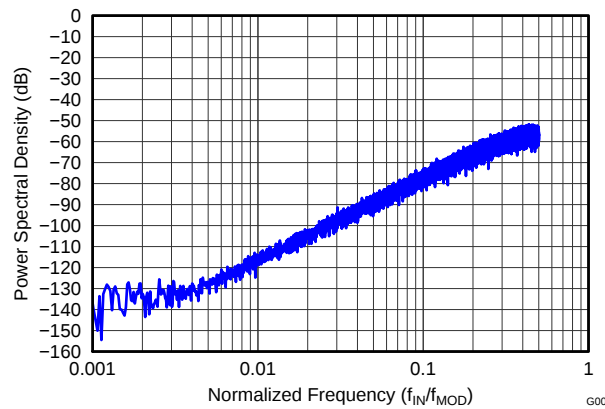
The differential (INP – INN) signal range depends on the analog supply and reference used in the system. Equation 3 shows this range.

$$\text{Max (INP – INN)} < \frac{V_{\text{REF}}}{\text{Gain}} ; \quad \text{Full-Scale Range} = \frac{\pm V_{\text{REF}}}{\text{Gain}} = \frac{2 V_{\text{REF}}}{\text{Gain}} \quad (3)$$

For higher dynamic range, a 5-V supply with a 4-V reference (set by the VREF\_4V bit of the [CONFIG3: Configuration Register 3](#)) can be used to increase the differential dynamic range.

### ADC $\Delta\Sigma$ Modulator

Each ADS130E08 channel has a 16-bit,  $\Delta\Sigma$  ADC. This converter uses a second-order modulator optimized for low-power applications. The modulator samples the input signal at the rate of  $f_{\text{MOD}} = f_{\text{CLK}} / 8$ . As in the case of any  $\Delta\Sigma$  modulator, the ADS130E08 noise is shaped until  $f_{\text{MOD}} / 2$ , as shown in Figure 20. The on-chip digital decimation filters also provide antialias filtering. This feature of the  $\Delta\Sigma$  converters drastically reduces the complexity of analog antialiasing filters typically required with nyquist ADCs.



**Figure 20. Modulator Noise Spectrum Up To  $0.5 \times f_{\text{MOD}}$**

## DIGITAL DECIMATION FILTER

The digital filter receives the modulator output and decimates the data stream. A fixed sample rate of 8 kSPS, for all eight channels, is provided for simplicity. The digital filter on each channel consists of a third-order sinc filter.

### Sinc Filter Stage (sinx / x)

The sinc filter is a variable decimation rate, third-order, low-pass filter. Data are supplied to this section of the filter from the modulator at the rate of  $f_{MOD}$ . The sinc filter attenuates the high-frequency noise of the modulator, then decimates the data stream into parallel data. The decimation rate affects the overall data rate of the converter.

[Equation 4](#) shows the scaled Z-domain transfer function of the sinc filter.

$$|H(z)| = \left| \frac{1 - Z^{-N}}{1 - Z^{-1}} \right|^3 \quad (4)$$

The frequency domain transfer function of the sinc filter is shown in [Equation 5](#).

$$H(f) = \left| \frac{\sin \left( \frac{N\pi f}{f_{MOD}} \right)}{N \times \sin \left( \frac{\pi f}{f_{MOD}} \right)} \right|^3$$

where:

$$N = \text{decimation ratio} \quad (5)$$

The sinc filter has notches (or zeroes) that occur at the output data rate and multiples thereof. At these frequencies, the filter has infinite attenuation. Figure 21 shows the sinc filter frequency response and Figure 22 shows the sinc filter roll-off. With a step change at the input, the filter takes  $3 t_{DR}$  to settle. After a START signal rising edge, the filter takes  $t_{SETTLE}$  time to output settled data. The settling time of the filters at various data rates is discussed in the **START** subsection of the **SPI Interface** section. Figure 23 and Figure 24 show the filter transfer function until  $f_{MOD} / 2$  and  $f_{MOD} / 16$ , respectively, at different data rates. Figure 25 shows the transfer function extended until  $4 f_{MOD}$ . The ADS130E08 passband repeats at every  $f_{MOD}$ . The input R-C antialiasing filters in the system should be chosen such that any interference in frequencies around multiples of  $f_{MOD}$  is attenuated sufficiently.

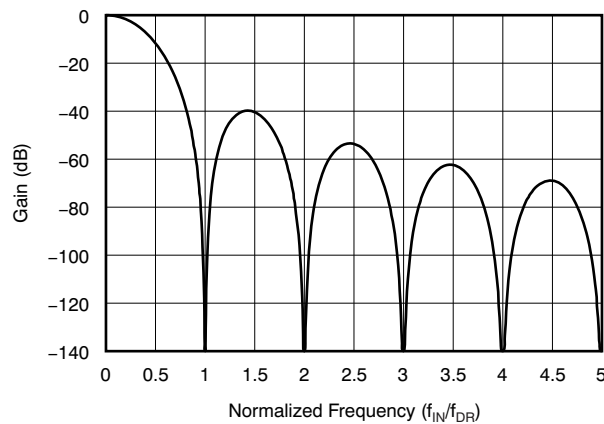


Figure 21. Sinc Filter Frequency Response

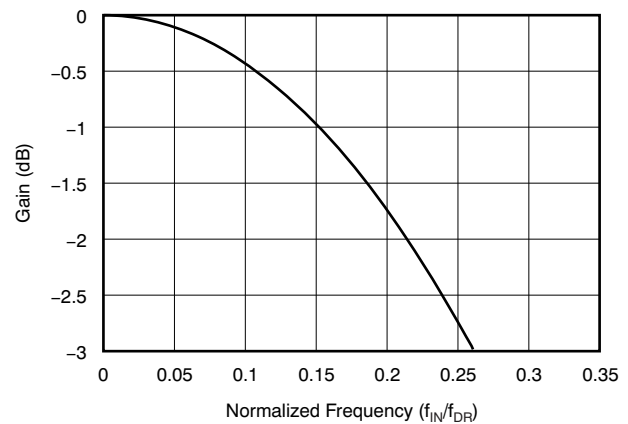
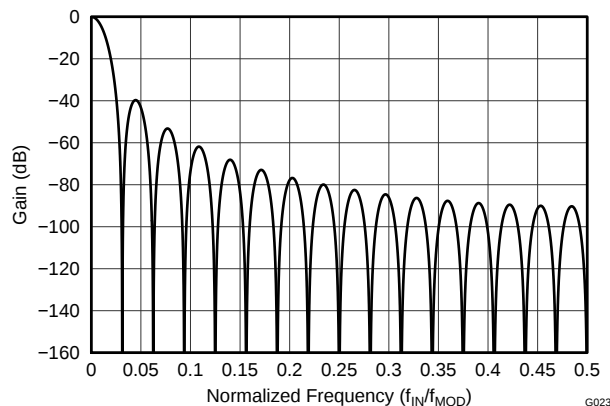
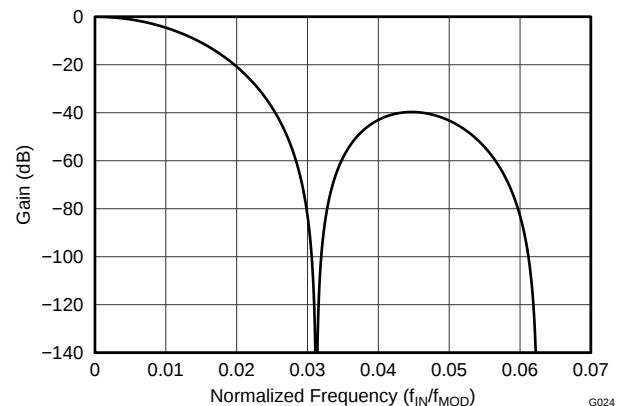
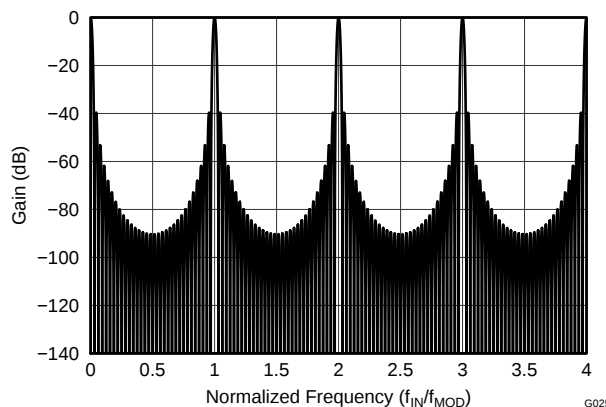


Figure 22. Sinc Filter Roll-Off

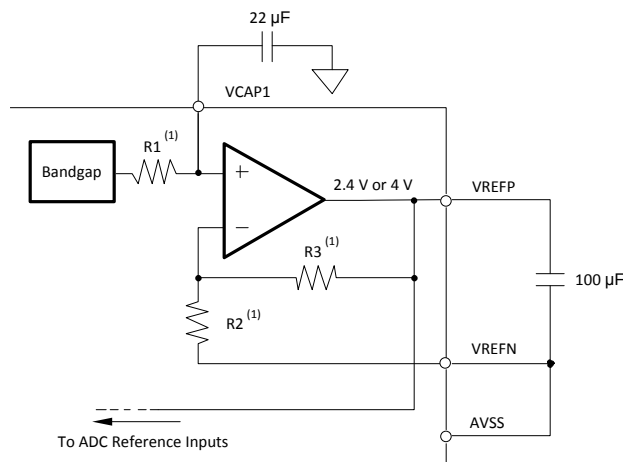
Figure 23. Transfer Function of On-Chip Decimation Filters Until  $f_{MOD} / 2$ Figure 24. Transfer Function of On-Chip Decimation Filters Until  $f_{MOD} / 16$



**Figure 25. Transfer Function of On-Chip Decimation Filters**  
Until  $4 f_{MOD}$  for DR[2:0] = 000 and DR[2:0] = 110

## REFERENCE

Figure 26 shows a simplified block diagram of the ADS130E08 internal reference. The reference voltage is generated with respect to AVSS. When using the internal voltage reference, connect VREFN to AVSS.



(1) For  $V_{REF} = 2.4$  V:  $R1 = 12.5$  k $\Omega$ ,  $R2 = 25$  k $\Omega$ , and  $R3 = 25$  k $\Omega$ . For  $V_{REF} = 4$  V:  $R1 = 10.5$  k $\Omega$ ,  $R2 = 15$  k $\Omega$ , and  $R3 = 35$  k $\Omega$ .

**Figure 26. Internal Reference**

The external band-limiting capacitors determine the amount of reference noise contribution. For high-end systems, the capacitor values should be chosen such that the bandwidth is limited to less than 10 Hz so that the reference noise does not dominate system noise. When using a 3-V analog supply, the internal reference must be set to 2.4 V. In case of a 5-V analog supply, the internal reference can be set to 4 V by setting the VREF\_4V bit in the [CONFIG2: Configuration Register 2](#).

Alternatively, the internal reference buffer can be powered down and VREFP can be driven externally. Figure 27 shows a typical external reference driver circuitry. Power-down is controlled by the PD\_REFBUF bit in the [CONFIG3: Configuration Register 3](#). This power-down is also used to share internal references when two devices are cascaded. By default, the device wakes up in external reference mode.

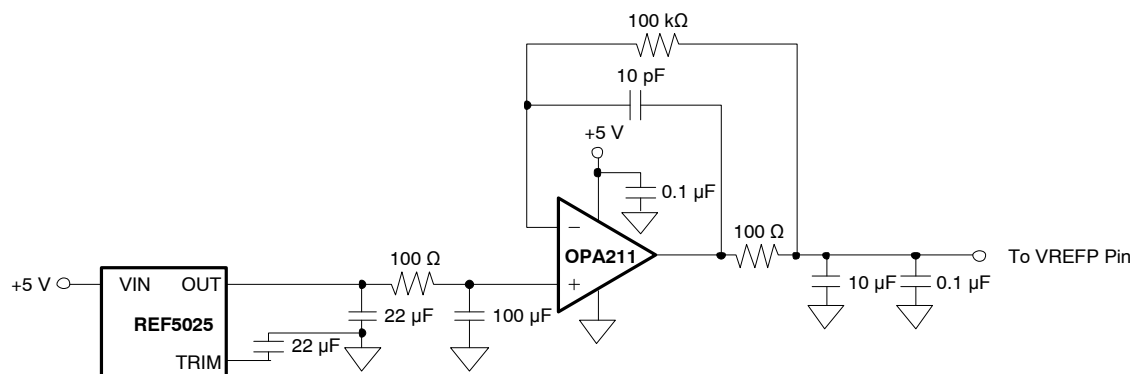


Figure 27. External Reference Driver

## CLOCK

The ADS130E08 provides two device clocking methods: internal and external. Internal clocking is ideally suited for low-power, battery-powered systems. The internal oscillator is trimmed for accuracy at room temperature. Accuracy varies over the specified temperature range; refer to the [Electrical Characteristics](#) for details. Clock selection is controlled by the CLKSEL pin and CLK\_EN register bit.

The CLKSEL pin selects either the internal or external clock. The CLK\_EN bit in the CONFIG1 register enables and disables the oscillator clock to be output in the CLK pin. A truth table for these pins is shown in [Table 2](#). The CLK\_EN bit is useful when multiple devices are used in a daisy-chain configuration. During power-down, the external clock is recommended to be shut down to save power.

**Table 2. CLKSEL Pin and CLK\_EN Bit**

| CLKSEL PIN | CONFIG1.CLK_EN BIT | CLOCK SOURCE              | CLK PIN STATUS                    |
|------------|--------------------|---------------------------|-----------------------------------|
| 0          | X                  | External clock            | Input: external clock             |
| 1          | 0                  | Internal clock oscillator | 3-state                           |
| 1          | 1                  | Internal clock oscillator | Output: internal clock oscillator |

## DATA FORMAT

The ADS130E08 outputs 16 bits of data per channel in binary twos complement format, MSB first. The LSB has a weight of  $[V_{REF} / (2^{15} - 1)]$ . A positive full-scale input produces an output code of 7FFFh and the negative full-scale input produces an output code of 8000h. The output clips at these codes for signals exceeding full-scale. [Table 3](#) summarizes the ideal output codes for different input signals.

**Table 3. Ideal Output Code versus Input Signal**

| INPUT SIGNAL, $V_{IN}$<br>( $A_{INP} - A_{INN}$ ) | IDEAL OUTPUT CODE <sup>(1)</sup> |
|---------------------------------------------------|----------------------------------|
| $\geq V_{REF}$                                    | 7FFFh                            |
| $+V_{REF} / (2^{15} - 1)$                         | 0001h                            |
| 0                                                 | 0000h                            |
| $-V_{REF} / (2^{15} - 1)$                         | FFFFh                            |
| $\leq -V_{REF} (2^{15} / 2^{15} - 1)$             | 8000h                            |

(1) Excludes effects of noise, linearity, offset, and gain error.

## SPI INTERFACE

The SPI-compatible serial interface consists of four signals:  $\overline{CS}$ , SCLK, DIN, and DOUT. The interface reads conversion data, reads and writes registers, and controls device operation. The  $\overline{DRDY}$  output is used as a status signal to indicate when data are ready.  $\overline{DRDY}$  goes low when new data are available.

### Chip Select ( $\overline{CS}$ )

$\overline{CS}$  selects the ADS130E08 for SPI communication.  $\overline{CS}$  must remain low for the entire serial communication duration. After the serial communication is finished, always wait four or more  $t_{CLK}$  cycles before taking  $\overline{CS}$  high. When  $\overline{CS}$  is taken high, the serial interface is reset, SCLK and DIN are ignored, and DOUT enters a high-impedance state.  $\overline{DRDY}$  asserts when data conversion is complete, regardless of whether  $\overline{CS}$  is high or low.

### Serial Clock (SCLK)

SCLK is the serial peripheral interface (SPI) serial clock. SCLK shifts commands in and shifts data out from the device. The serial clock features a Schmitt-triggered input and clocks data on the DIN and DOUT pins into and out of the ADS130E08.

Care should be taken to prevent glitches on SCLK while  $\overline{CS}$  is low. Glitches as small as 1 ns wide could be interpreted as a valid serial clock. After eight serial clock events, the ADS130E08 assumes an instruction must be interrupted and executed. If it is suspected that instructions are being interrupted erroneously, toggle  $\overline{CS}$  high and back low to return the chip to normal operation. Issuing serial clocks in multiples of eight is also recommended. The absolute maximum SCLK limit is specified in the [Serial Interface Timing](#) table.

For a single device, the minimum speed needed for SCLK depends on the number of channels, number of bits of resolution, and output data rate. (For multiple cascaded devices, see the [Standard Mode](#) subsection of the [Multiple Device Configuration](#) section.) For example, at 8 kSPS, the minimum serial clock rate must be 1.3 MHz.

Data can be retrieved either by putting the device in RDATA mode or by issuing an RDATA command for data on demand. The SCLK rate limitation, as described by [Equation 6](#), applies to RDATA mode. For the RDATA command, the limitation applies if data must be read in between two consecutive  $\overline{DRDY}$  signals. [Equation 6](#) assumes that there are no other commands issued in between data captures.

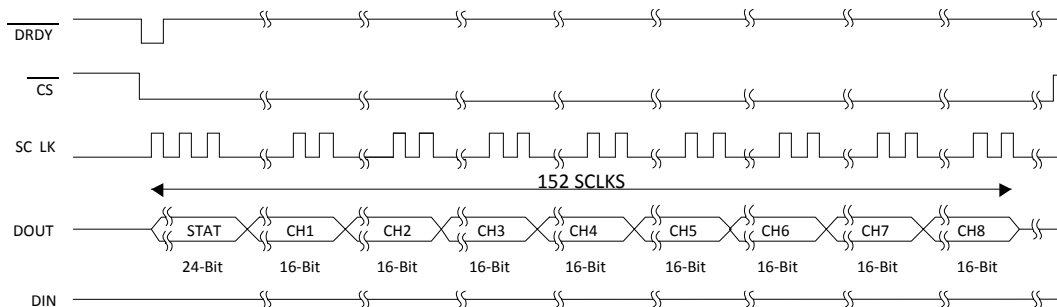
$$t_{SCLK} < \frac{t_{DR} - 4 t_{CLK}}{152} \quad (6)$$

### Data Input (DIN)

The data input pin (DIN) is used along with SCLK to communicate with the ADS130E08 (using opcode commands and register data). The device latches data on DIN on the SCLK falling edge.

### Data Output (DOUT)

The data output pin (DOUT) is used with SCLK to read conversions and register data from the ADS130E08. Data on DOUT are shifted out on the SCLK rising edge. DOUT goes to a high-impedance state when  $\overline{CS}$  is high. In read data continuous mode (see the [SPI Command Definitions](#) section for more details), the DOUT output line also indicates when new data are available. This feature can be used to minimize the number of connections between the device and system controller. [Figure 28](#) shows the data output protocol for the ADS130E08.



**Figure 28. SPI Bus Data Output**

### Data Retrieval

Data retrieval can be accomplished in one of two methods. The read data continuous command (see the [RDATA: Read Data Continuous](#) section) can be used to set the device in a mode to read data continuously without sending opcodes. The read data command (see the [RDATA: Read Data](#) section) can be used to read just one data output from the device (see the [SPI Command Definitions](#) section for more details). Conversion data are read by shifting data out on DOUT. The MSB of the data on DOUT is clocked out on the first SCLK rising edge.  $\overline{DRDY}$  returns to high on the first SCLK falling edge. DIN should remain low for the entire read operation.

The number of bits in the data output depends on the number of channels and the number of bits per channel. For the ADS130E08, the number of data outputs is [(24 status bits + 16 bits × 8 channels) = 152 bits]. The format of the 24 status bits is (1100 + FAULT\_STATP + FAULT\_STATN + bits[7:4] of the [GPIO: General-Purpose IO Register](#)). The data format for each channel data is two's complement, MSB first. When channels are powered down using user register settings, the corresponding channel output is set to '0'. However, the channel output sequence remains the same.

The ADS130E08 also provides a multiple readback feature. Data can be read out multiple times by simply giving more SCLKs, in which case the MSB data byte repeats after reading the last byte. The DAISY\_IN bit in the [CONFIG1: Configuration Register 1](#) must be set to '1' for multiple readbacks.

### Data Ready ( $\overline{\text{DRDY}}$ )

$\overline{\text{DRDY}}$  is an output. When  $\overline{\text{DRDY}}$  transitions low, new conversion data are ready. The  $\overline{\text{CS}}$  signal has no effect on the data ready signal.  $\overline{\text{DRDY}}$  behavior is determined by whether the device is in RDATA\_C mode or the RDATA command is being used to read data on demand. (See the [RDATA\\_C: Read Data Continuous](#) and [RDATA: Read Data](#) subsections of the [SPI Command Definitions](#) section for further details). When reading data with the RDATA command, the read operation can overlap the next  $\overline{\text{DRDY}}$  occurrence without data corruption.

The START pin or the START command is used to place the device either in normal data capture mode or pulse data capture mode. [Figure 29](#) shows the relationship between  $\overline{\text{DRDY}}$ , DOUT, and SCLK during data retrieval. DOUT is latched out at the SCLK rising edge;  $\overline{\text{DRDY}}$  is pulled high at the SCLK falling edge. Note that  $\overline{\text{DRDY}}$  goes high on the first SCLK falling edge, regardless of whether data are being retrieved from the device or a command is being sent through the DIN pin.

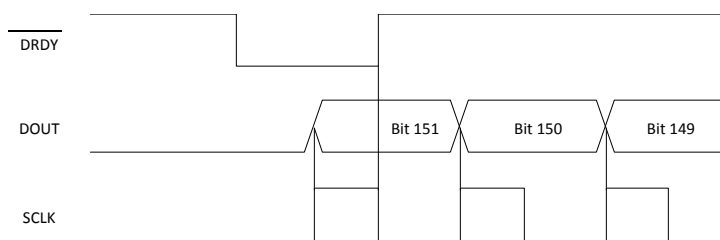


Figure 29.  $\overline{\text{DRDY}}$  with Data Retrieval ( $\overline{\text{CS}} = 0$ )

### GPIO

The ADS130E08 has a total of four general-purpose digital input and output (GPIO) pins available in the normal mode of operation. The digital IO pins are individually configurable as either inputs or outputs through the GPIOC bits register. The GPIOD bits in the [GPIO: General-Purpose IO Register](#) control the level of the pins. When reading the GPIOD bits, the data returned are the logic level of the pins, whether they are programmed as inputs or outputs. When the GPIO pin is configured as an input, a write to the corresponding GPIOD bit has no effect. When configured as an output, a write to the GPIOD bit sets the output value.

If configured as inputs, these pins must be driven (do not float). The GPIO pins are set as inputs after power-on or after a reset. [Figure 30](#) shows the GPIO port structure. The pins should be connected to DGND if not used.

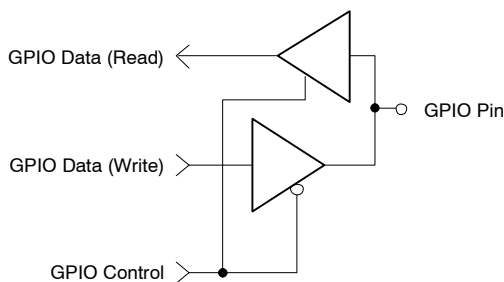


Figure 30. GPIO Port Pin

### Power-Down ( $\overline{\text{PWDN}}$ )

When  $\overline{\text{PWDN}}$  is pulled low, all on-chip circuitry is powered down. To exit power-down mode, take the  $\overline{\text{PWDN}}$  pin high. Upon exiting from power-down mode, the internal oscillator and reference require time to wake up. During power-down, the external clock is recommended to be shut down to save power.

## Reset (RESET)

There are two methods to reset the ADS130E08: pulling the  $\overline{\text{RESET}}$  pin low, or sending the  $\overline{\text{RESET}}$  opcode command. When using the  $\overline{\text{RESET}}$  pin, take the pin low to force a reset. Make sure to follow the minimum pulse width timing specifications before taking the  $\overline{\text{RESET}}$  pin back high. The  $\overline{\text{RESET}}$  command takes effect on the eighth SCLK falling edge of the opcode command. On reset,  $18 t_{\text{CLK}}$  cycles are required to complete initialization of the configuration registers to the default states and start the conversion cycle. Note that an internal  $\overline{\text{RESET}}$  is automatically issued to the digital filter whenever the CONFIG1 Register is set to a new value with a WREG command.

## START

The START pin must be set high or the START command sent to begin conversions. When START is low or if the START command has not been sent, the device does not issue a  $\overline{\text{DRDY}}$  signal (conversions are halted).

When using the START opcode to control conversions, hold the START pin low. In multiple device configurations the START pin is used to synchronize devices (see the [Multiple Device Configuration](#) subsection of the [SPI Interface](#) section for more details).

## Settling Time

The settling time ( $t_{\text{SETTLE}}$ ) is the time required for the converter to output fully-settled data when the START signal is pulled high. When START is pulled high,  $\overline{\text{DRDY}}$  is also pulled high. The next  $\overline{\text{DRDY}}$  falling edge indicates that data are ready. Figure 31 shows the timing diagram and shows the data rate settling time. The settling time depends on  $f_{\text{CLK}}$  and is  $1160 t_{\text{CLK}}$ . Note that when START is held high and there is a step change in the input signal,  $3 t_{\text{DR}}$  is required for the filter to settle to the new value. Settled data are available on the fourth  $\overline{\text{DRDY}}$  pulse.

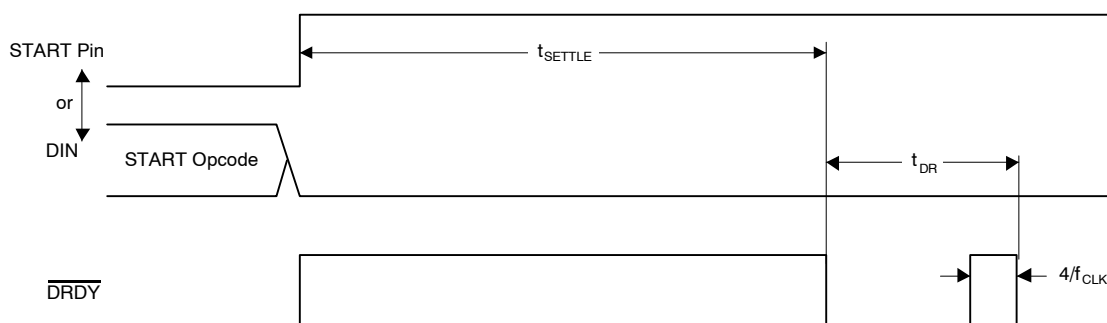
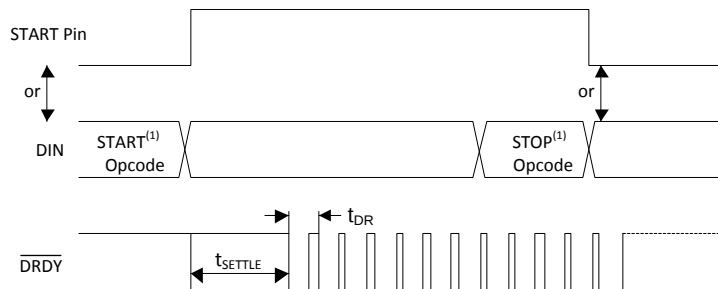


Figure 31. Settling Time

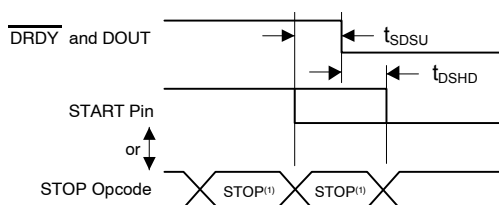
## Continuous Mode

Conversions begin when the START pin is taken high or when the START opcode command is sent. As seen in Figure 32, the  $\overline{\text{DRDY}}$  output goes high when conversions are started and then goes low when data are ready. Conversions continue indefinitely until the START pin is taken low or the STOP opcode command is transmitted. When the START pin is pulled low or the stop command is issued, the conversion in progress is allowed to complete. Figure 33 and Table 4 show the required  $\overline{\text{DRDY}}$  timing to the START pin and the START and STOP opcode commands when controlling conversions in this mode. To keep the converter running continuously, the START pin can be permanently tied high.



(1) START and STOP opcode commands take effect on the seventh SCLK falling edge.

**Figure 32. Continuous Conversion Mode**



(1) START and STOP commands take effect on the seventh SCLK falling edge at the end of the opcode transmission.

**Figure 33. START to  $\overline{\text{DRDY}}$  Timing**

**Table 4. Timing Characteristics for Figure 33<sup>(1)</sup>**

| SYMBOL            | DESCRIPTION                                                                                     | MIN | UNIT               |
|-------------------|-------------------------------------------------------------------------------------------------|-----|--------------------|
| $t_{\text{SDSU}}$ | START pin low or STOP opcode to $\overline{\text{DRDY}}$ setup time to halt further conversions | 16  | $1/f_{\text{CLK}}$ |
| $t_{\text{DSHD}}$ | START pin low or STOP opcode to complete current conversion                                     | 16  | $1/f_{\text{CLK}}$ |

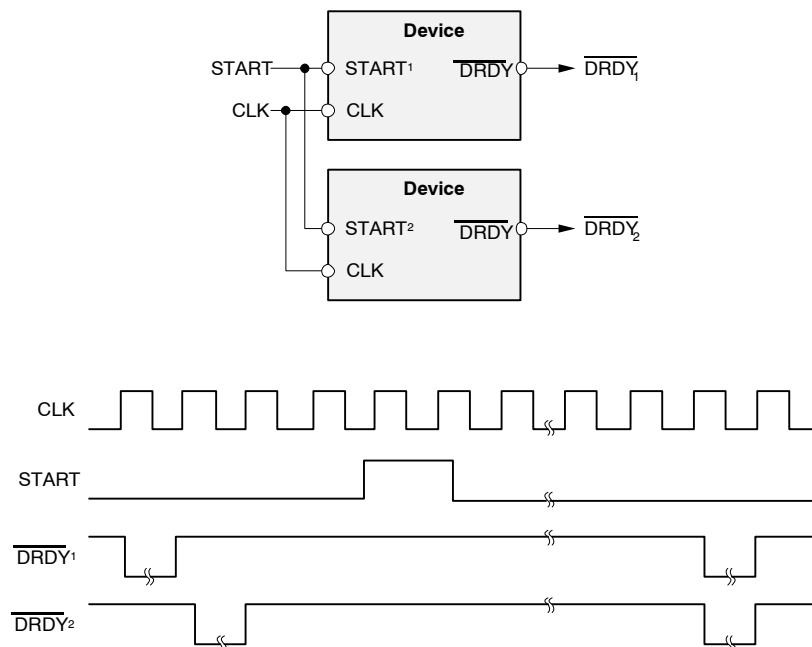
(1) START and STOP commands take effect on the seventh SCLK falling edge at the end of the opcode transmission.

## MULTIPLE DEVICE CONFIGURATION

The ADS130E08 is designed to provide configuration flexibility when multiple devices are used in a system. The serial interface typically needs four signals: DIN, DOUT, SCLK, and  $\overline{\text{CS}}$ . With one additional chip select signal per device, multiple devices can be connected together. The number of signals needed to interface  $n$  devices is  $3 + n$ .

When using multiple devices, the devices can be synchronized with the START signal. The delay from START to the  $\overline{\text{DRDY}}$  signal is fixed for a fixed data rate (see the [START](#) subsection of the [SPI Interface](#) section for more details on settling times). [Figure 34](#) shows the behavior of two devices when synchronized with the START signal.

There are two ways to connect multiple devices with an optimal number of interface pins: cascade mode and daisy-chain mode.



**Figure 34. Synchronizing Multiple Converters**

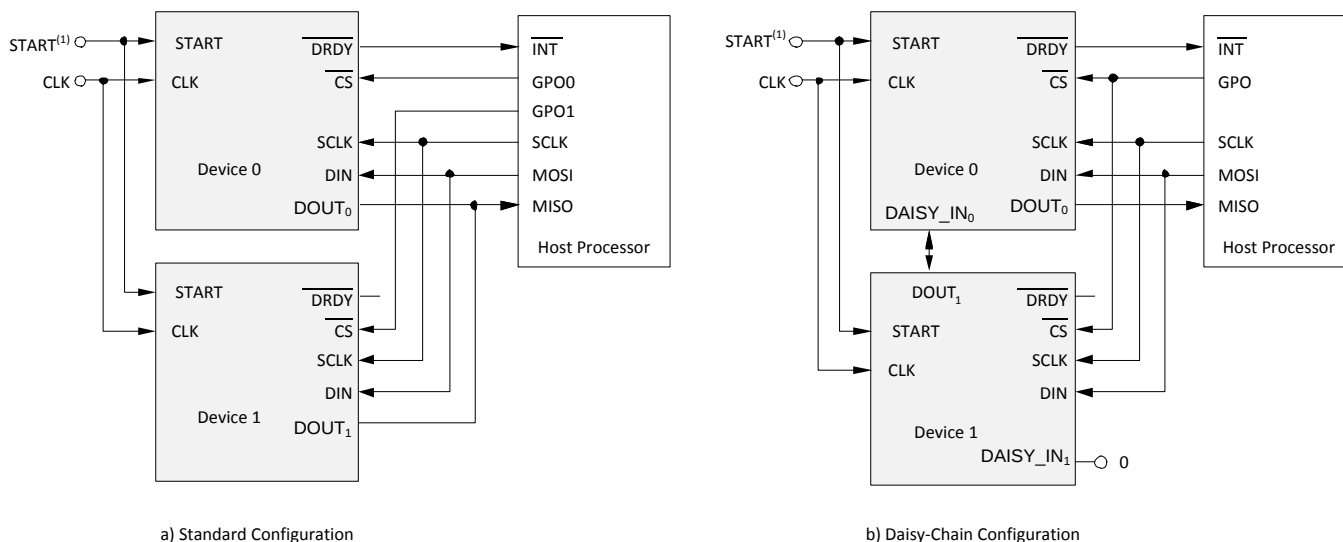
## Cascade Mode

Figure 35a shows a configuration with two devices cascaded together. Both devices are an ADS130E08 device. Together, the devices create a system with 16 channels. DOUT, SCLK, and DIN are shared. Each device has its own chip select. When a device is not selected by the corresponding CS being driven to logic '1', the DOUT of this device is high-impedance. This structure allows the other device to take control of the DOUT bus. This configuration method is suitable for the majority of applications.

## Daisy-Chain Mode

Daisy-chain mode is enabled by setting the DAISY\_IN bit in the [CONFIG1: Configuration Register 1](#). Figure 35b shows the daisy-chain configuration. In this mode SCLK, DIN, and CS are shared across multiple devices. The DOUT pin of one device is connected to the DAISY\_IN of the other device, thereby creating a chain. One extra SCLK must be issued between each data set. Also, when using daisy-chain mode, the multiple readback feature is not available. Short the DAISY\_IN pin to digital ground if not used. Figure 2 describes the required timing for the ADS130E08 shown in Figure 35. Data from the ADS130E08 appear first on DOUT, followed by a *don't care* bit, and finally by the status and data words from the second ADS130E08 device.

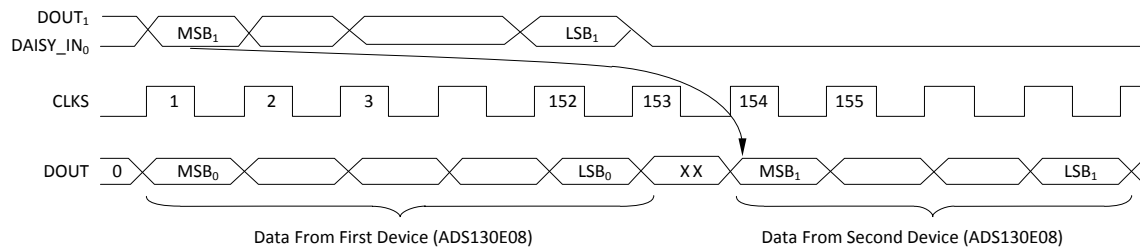
When all devices in the chain operate in the same register setting, DIN can be shared as well. This configuration reduces the SPI communication signals to four, regardless of the number of devices.



(1) To reduce pin count, set the START pin low and use the START serial command to synchronize and start conversions.

**Figure 35. Multiple Device Configurations**

Note that from [Figure 2](#), the SCLK rising edge shifts data out of the ADS130E08 on DOUT. The SCLK rising edge is also used to latch data into the device DAISY\_IN pin down the chain. This architecture allows for a faster SCLK rate speed, but also makes the interface sensitive to board-level signal delays. The more devices in the chain, the more challenging it can become to adhere to setup and hold times. An SCLK star-pattern connection to all devices, minimizing DOUT length, and other printed circuit board (PCB) layout techniques helps. Placing delay circuits (such as buffers) between DOUT and DAISY\_IN also helps mitigate this challenge. One other option is to insert a *D* flip-flop between DOUT and DAISY\_IN clocked on an inverted SCLK. Also note that daisy-chain mode requires some software overhead to recombine data bits spread across byte boundaries. [Figure 36](#) shows a timing diagram for daisy-chain mode.



**Figure 36. Daisy-Chain Timing**

The maximum number of devices that can be daisy-chained depends on the data rate at which the device is operated at. The maximum number of devices can be approximately calculated with [Equation 7](#).

$$N_{\text{DEVICES}} = \frac{f_{\text{SCLK}}}{152 \times f_{\text{DR}}} \quad (7)$$

## SPI COMMAND DEFINITIONS

The ADS130E08 provides flexible configuration control. The opcode commands summarized in [Table 5](#) control and configure device operation. The opcode commands are stand-alone, except for the register read and write operations that require a second command byte plus data.  $\overline{CS}$  can be taken high or held low between opcode commands but must stay low for the entire command operation (especially for multibyte commands). System opcode commands and the RDATA command are decoded by the ADS130E08 on the seventh SCLK falling edge. The register read and write opcodes are decoded on the eighth SCLK falling edge. Be sure to follow SPI timing requirements when pulling  $\overline{CS}$  high after issuing a command.

**Table 5. Command Definitions**

| COMMAND                       | DESCRIPTION                                                                                 | FIRST BYTE                          | SECOND BYTE                   |
|-------------------------------|---------------------------------------------------------------------------------------------|-------------------------------------|-------------------------------|
| <b>System Commands</b>        |                                                                                             |                                     |                               |
| WAKEUP                        | Wake-up from standby mode                                                                   | 0000 0010 (02h)                     |                               |
| STANDBY                       | Enter standby mode                                                                          | 0000 0100 (04h)                     |                               |
| $\overline{RESET}$            | Reset the device                                                                            | 0000 0110 (06h)                     |                               |
| START                         | Start or restart (synchronize) conversions                                                  | 0000 1000 (08h)                     |                               |
| STOP                          | Stop conversion                                                                             | 0000 1010 (0Ah)                     |                               |
| <b>Data Read Commands</b>     |                                                                                             |                                     |                               |
| RDATA                         | Enable Read Data Continuous mode. This mode is the default mode at power-up. <sup>(1)</sup> | 0001 0000 (10h)                     |                               |
| SDATA                         | Stop Read Data Continuously mode                                                            | 0001 0001 (11h)                     |                               |
| RDATA                         | Read data by command; supports multiple readback.                                           | 0001 0010 (12h)                     |                               |
| <b>Register Read Commands</b> |                                                                                             |                                     |                               |
| RREG                          | Read $n$ $nnnn$ registers starting at address $r$ $rrrr$                                    | 001 $r$ $rrrr$ (2xh) <sup>(2)</sup> | 000 $n$ $nnnn$ <sup>(2)</sup> |
| WREG                          | Write $n$ $nnnn$ registers starting at address $r$ $rrrr$                                   | 010 $r$ $rrrr$ (4xh) <sup>(2)</sup> | 000 $n$ $nnnn$ <sup>(2)</sup> |

(1) When in RDATA mode, the RREG command is ignored.

(2)  $n$   $nnnn$  = number of registers to be read or written – 1. For example, to read or write three registers, set  $n$   $nnnn$  = 0 (0010).  $r$   $rrrr$  = starting register address for read and write opcodes.

### WAKEUP: Exit STANDBY Mode

This opcode exits the low-power standby mode; see the [STANDBY: Enter STANDBY Mode](#) subsection of the [SPI Command Definitions](#) section. Time is required when exiting standby mode (see the [Electrical Characteristics](#) for details). **There are no SCLK rate restrictions for this command and it can be issued at any time.** The next command must be sent after a delay of 4  $t_{CLK}$  cycles.

### STANDBY: Enter STANDBY Mode

This opcode command enters the low-power standby mode. All parts of the circuit are shut down except for the reference section. The standby mode power consumption is specified in the [Electrical Characteristics](#). **There are no SCLK rate restrictions for this command and it can be issued at any time.** Do not send any other commands other than the wakeup command after the device enters standby mode.

### $\overline{RESET}$ : Reset Registers to Default Values

This command resets the digital filter cycle and returns all register settings to the default values. See the [Reset \(RESET\)](#) subsection of the [SPI Interface](#) section for more details. **There are no SCLK rate restrictions for this command and it can be issued at any time.** 18  $t_{CLK}$  cycles are required to execute the  $\overline{RESET}$  command. Avoid sending any commands during this time.

### START: Start Conversions

This opcode starts data conversions. Tie the START pin low to control conversions by command. If conversions are in progress, this command has no effect. The STOP opcode command is used to stop conversions. If the START command is immediately followed by a STOP command, then a gap of 4  $t_{CLK}$  cycles must be between them. When the START opcode is sent to the device, keep the START pin low until the STOP command is issued. (See the [START](#) subsection of the [SPI Interface](#) section for more details.) **There are no SCLK rate restrictions for this command and it can be issued at any time.**

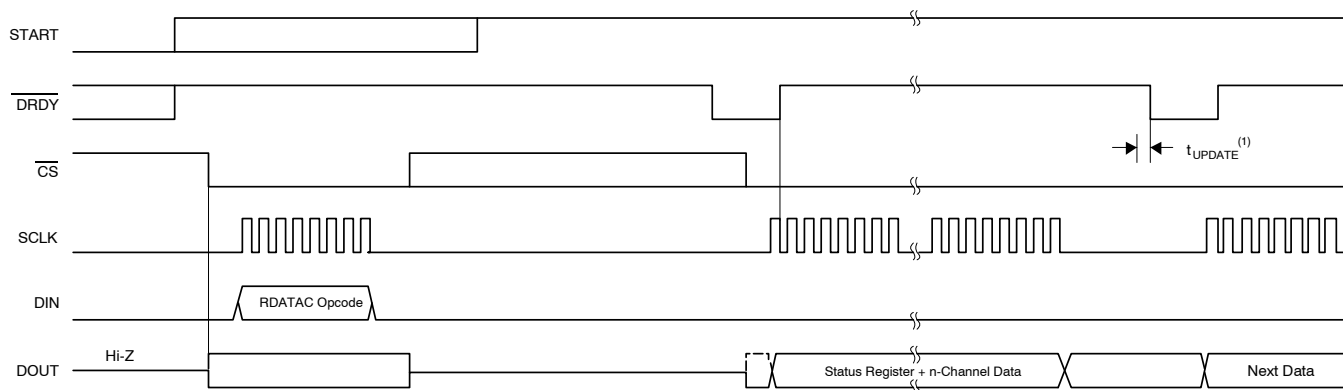
## STOP: Stop Conversions

This opcode stops conversions. Tie the START pin low to control conversions by command. When the STOP command is sent, the conversion in progress completes and further conversions are stopped. If conversions are already stopped, this command has no effect. **There are no SCLK rate restrictions for this command and it can be issued at any time.**

## RDATAC: Read Data Continuous

This opcode enables conversion data output on each  $\overline{\text{DRDY}}$  without the need to issue subsequent read data opcodes. This mode places the conversion data in the output register and may be shifted out directly. The read data continuous mode is the device default mode; the device defaults to this mode on power-up.

RDATAC mode is cancelled by the Stop Read Data Continuous command. If the device is in RDATAC mode, an SDATAC command must be issued before any other commands can be sent to the device. There is no SCLK rate restriction for this command. However, the subsequent data-retrieval SCLKs or the SDATAC opcode command should wait at least  $4 t_{\text{CLK}}$  cycles for the command to execute. RDATAC timing is shown in Figure 37. As Figure 37 shows, there is a *keep out zone* of  $4 t_{\text{CLK}}$  cycles around the  $\overline{\text{DRDY}}$  pulse where this command cannot be issued in. If no data are retrieved from the device, DOUT and  $\overline{\text{DRDY}}$  behave similarly in this mode. To retrieve data from the device after the RDATAC command is issued, make sure either the START pin is high or the START command is issued. Figure 37 shows the recommended way to use the RDATAC command. RDATAC is ideally-suited for applications such as data loggers or recorders where registers are set once and do not need to be reconfigured.



(1)  $t_{\text{UPDATE}} = 4 / f_{\text{CLK}}$ . Do not read data during this time.

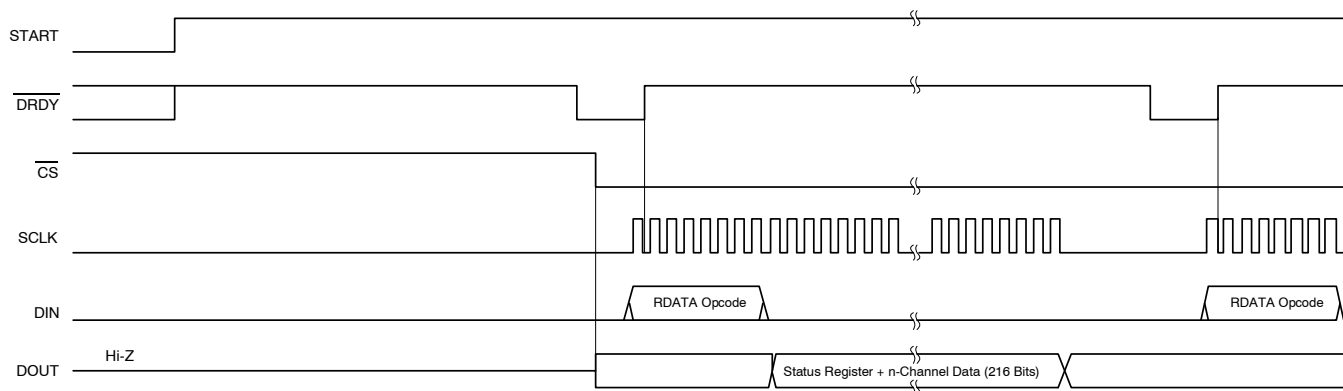
**Figure 37. RDATAC Usage**

## SDATAC: Stop Read Data Continuous

This opcode cancels the Read Data Continuous mode. There is no SCLK rate restriction for this command, but the next command must wait 4  $t_{CLK}$  cycles to execute.

## RDATA: Read Data

Issue this command after  $\overline{DRDY}$  goes low to read the conversion result (in Stop Read Data Continuous mode). There is no SCLK rate restriction for this command, and there is no wait time needed for subsequent commands or data-retrieval SCLKs. To retrieve data from the device after the RDATA command is issued, make sure either the START pin is high or the START command is issued. When reading data with the RDATA command, the read operation can overlap the next  $\overline{DRDY}$  occurrence without data corruption. Figure 38 shows the recommended way to use the RDATA command. RDATA is best suited for systems where register settings must be read or changed often between conversion cycles.



**Figure 38. RDATA Usage**

## Sending Multibyte Commands

The ADS130E08 serial interface decodes commands in bytes and requires 4  $t_{CLK}$  cycles to decode and execute. Therefore, when sending multibyte commands, a 4- $t_{CLK}$  period must separate the end of one byte (or opcode) and the next.

Assuming CLK is 2.048 MHz, then  $t_{SDECODE}$  (4  $t_{CLK}$ ) is 1.96  $\mu$ s. When SCLK is 16 MHz, one byte can be transferred in 500 ns. This byte-transfer time does not meet the  $t_{SDECODE}$  specification; therefore, a delay must be inserted so the end of the second byte arrives 1.46  $\mu$ s later. If SCLK is 4 MHz, one byte is transferred in 2  $\mu$ s. Because this transfer time exceeds the  $t_{SDECODE}$  specification, the processor can send subsequent bytes without delay. In this later scenario, the serial port can be programmed to move from single-byte transfers per cycle to multiple bytes.

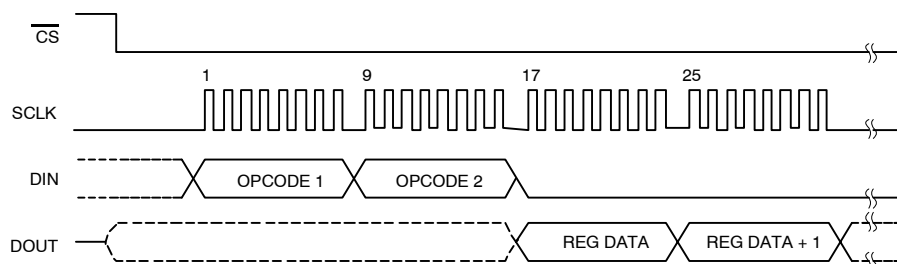
## RREG: Read From Register

This opcode reads register data. The Register Read command is a two-byte opcode followed by the register data output. The first byte contains the command opcode and register address. The second opcode byte specifies the number of registers to read – 1.

First opcode byte: 001r rrrr, where r rrrr is the starting register address.

Second opcode byte: 000n nnnn, where n nnnn is the number of registers to read – 1.

The 17th SCLK rising edge of the operation clocks out the MSB of the first register, as shown in Figure 39. When the device is in read data continuous mode, an SDATAC command must be issued before the RREG command can be issued. The RREG command can be issued at any time. However, because this command is a multibyte command, there are SCLK rate restrictions depending on how the SCLKs are issued. See the [Serial Clock \(SCLK\)](#) subsection of the [SPI Interface](#) section for more details. Note that  $\overline{\text{CS}}$  must be low for the entire command.



**Figure 39. RREG Command Example: Read Two Registers Starting from Register 00h (ID Register)**  
(OPCODE 1 = 0010 0000, OPCODE 2 = 0000 0001)

## WREG: Write to Register

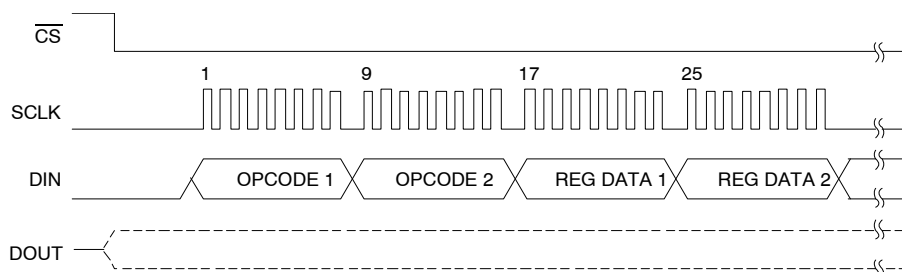
This opcode writes register data. The Register Write command is a two-byte opcode followed by the register data input. The first byte contains the command opcode and the register address.

The second opcode byte specifies the number of registers to write – 1.

First opcode byte: 010r rrrr, where r rrrr is the starting register address.

Second opcode byte: 000n nnnn, where n nnnn is the number of registers to write – 1.

After the opcode bytes, the register data follows (in MSB-first format), as shown in Figure 40. The WREG command can be issued at any time. However, because this command is a multibyte command, there are SCLK rate restrictions depending on how the SCLKs are issued. See the [Serial Clock \(SCLK\)](#) subsection of the [SPI Interface](#) section for more details. Note that  $\overline{\text{CS}}$  must be low for the entire command.



**Figure 40. WREG Command Example: Write Two Registers Starting from 00h (ID Register)**  
(OPCODE 1 = 0100 0000, OPCODE 2 = 0000 0001)

## REGISTER MAP

Table 6 describes the various ADS130E08 registers.

**Table 6. Register Assignments<sup>(1)</sup>**

| ADDRESS                                                    | REGISTER    | RESET<br>VALUE<br>(Hex) | BIT 7      | BIT 6      | BIT 5      | BIT 4      | BIT 3      | BIT 2      | BIT 1      | BIT 0      |
|------------------------------------------------------------|-------------|-------------------------|------------|------------|------------|------------|------------|------------|------------|------------|
| <b>Device Settings (Read-Only Registers)</b>               |             |                         |            |            |            |            |            |            |            |            |
| 00h                                                        | ID          | 52                      | REV_ID3    | REV_ID2    | REV_ID1    | 1          | 0          | DEV_ID1    | NU_CH2     | NU_CH1     |
| <b>Global Settings Across Channels</b>                     |             |                         |            |            |            |            |            |            |            |            |
| 01h                                                        | CONFIG1     | 01                      | 0          | 0          | CLK_EN     | 0          | 0          | 0          | 0          | 1          |
| 02h                                                        | CONFIG2     | 60                      | 0          | 1          | 1          | INT_TEST   | 0          | TEST_AMP   | TEST_FREQ1 | TEST_FREQ0 |
| 03h                                                        | CONFIG3     | 40                      | PD_REFBUF  | 1          | VREF_4V    | 0          | OPAMP_REF  | PD_OPAMP   | 0          | 0          |
| 04h                                                        | FAULT       | 00                      | COMP_TH2   | COMP_TH1   | COMP_TH0   | 0          | 0          | 0          | 0          | 0          |
| <b>Channel-Specific Settings</b>                           |             |                         |            |            |            |            |            |            |            |            |
| 05h                                                        | CH1SET      | 10                      | PD1        | GAIN12     | GAIN11     | GAIN10     | 0          | MUX12      | MUX11      | MUX10      |
| 06h                                                        | CH2SET      | 10                      | PD2        | GAIN22     | GAIN21     | GAIN20     | 0          | MUX22      | MUX21      | MUX20      |
| 07h                                                        | CH3SET      | 10                      | PD3        | GAIN32     | GAIN31     | GAIN30     | 0          | MUX32      | MUX31      | MUX30      |
| 08h                                                        | CH4SET      | 10                      | PD4        | GAIN42     | GAIN41     | GAIN40     | 0          | MUX42      | MUX41      | MUX40      |
| 09h                                                        | CH5SET      | 10                      | PD5        | GAIN52     | GAIN51     | GAIN50     | 0          | MUX52      | MUX51      | MUX50      |
| 0Ah                                                        | CH6SET      | 10                      | PD6        | GAIN62     | GAIN61     | GAIN60     | 0          | MUX62      | MUX61      | MUX60      |
| 0Bh                                                        | CH7SET      | 10                      | PD7        | GAIN72     | GAIN71     | GAIN70     | 0          | MUX72      | MUX71      | MUX70      |
| 0Ch                                                        | CH8SET      | 10                      | PD8        | GAIN82     | GAIN81     | GAIN80     | 0          | MUX82      | MUX81      | MUX80      |
| <b>Fault Detect Status Registers (Read-Only Registers)</b> |             |                         |            |            |            |            |            |            |            |            |
| 12h                                                        | FAULT_STATP | 00                      | IN8P_FAULT | IN7P_FAULT | IN6P_FAULT | IN5P_FAULT | IN4P_FAULT | IN3P_FAULT | IN2P_FAULT | IN1P_FAULT |
| 13h                                                        | FAULT_STATN | 00                      | IN8N_FAULT | IN7N_FAULT | IN6N_FAULT | IN5N_FAULT | IN4N_FAULT | IN3N_FAULT | IN2N_FAULT | IN1N_FAULT |
| <b>GPIO and Other Registers</b>                            |             |                         |            |            |            |            |            |            |            |            |
| 14h                                                        | GPIO        | 0F                      | GPIO4      | GPIO3      | GPIO2      | GPIO1      | GPIOC4     | GPIOC3     | GPIOC2     | GPIOC1     |

(1) Registers 0Dh, 0Eh, 0Fh, 10h, and 11h must be written as all '0's.

## User Register Description

### ID: ID Control Register (Factory-Programmed, Read-Only)

Address = 00h

| BIT 7   | BIT 6   | BIT 5   | BIT 4 | BIT 3 | BIT 2   | BIT 1  | BIT 0  |
|---------|---------|---------|-------|-------|---------|--------|--------|
| REV_ID3 | REV_ID2 | REV_ID1 | 1     | 0     | DEV_ID1 | NU_CH2 | NU_CH1 |

This register is programmed during device manufacture to indicate device characteristics.

- Bits[7:5] REV\_ID[3:1]: Device family identification (read-only)**  
 These factory-programmed bits indicate the device version.  
 010 = ADS130E08  
 All others are reserved.
- Bit 4 Must be set to '1'**
- Bit 3 Must be set to '0'**
- Bits[1:0] DEV\_ID1 and NU\_CH[2:1]: Device identification bits (read-only)**  
 These factory-programmed bits indicate the device version.  
 010 = ADS130E08  
 All others are reserved.

### CONFIG1: Configuration Register 1

Address = 01h

| BIT 7 | BIT 6 | BIT 5  | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|-------|--------|-------|-------|-------|-------|-------|
| 0     | 0     | CLK_EN | 0     | 0     | 0     | 0     | 1     |

This register is reserved for device manufacturing.

- Bits[7:6] Must be set to '0'**
- Bit 5 CLK\_EN: CLK connection<sup>(1)</sup>**  
 This bit determines if the internal oscillator signal is connected to the CLK pin when the CLKSEL pin is '1'.  
 0 = Oscillator clock output disabled (default)  
 1 = Oscillator clock output enabled
- Bits[4:1] Must be set to '0'**
- Bit 0 Must be set to '1'**

(1) Additional power is consumed when driving external devices.

### CONFIG2: Configuration Register 2

Address = 02h

| BIT 7 | BIT 6 | BIT 5 | BIT 4    | BIT 3 | BIT 2    | BIT 1      | BIT 0      |
|-------|-------|-------|----------|-------|----------|------------|------------|
| 0     | 1     | 1     | INT_TEST | 0     | TEST_AMP | TEST_FREQ1 | TEST_FREQ0 |

This register configures test signal generation. See the [Input Multiplexer](#) section for more details.

**Bit 7**      **Must be set to '0'**

**Bits[6:5]**      **Must be set to '1'**

**Bit 4**      **INT\_TEST: Test source**

This bit determines the test signal source.

0 = Test signals are driven externally (default)

1 = Test signals are generated internally

**Bit 3**      **Must be set to '0'**

**Bit 2**      **TEST\_AMP: Test signal amplitude**

This bit determines the Calibration signal amplitude.

0 =  $1 \times -(V_{REFP} - V_{REFN}) / 2.4 \text{ mV}$  (default)

1 =  $2 \times -(V_{REFP} - V_{REFN}) / 2.4 \text{ mV}$

**Bits[1:0]**      **TEST\_FREQ[1:0]: Test signal frequency**

These bits determine the calibration signal frequency.

00 = Pulsed at  $f_{CLK} / 2^{21}$  (default)

01 = Pulsed at  $f_{CLK} / 2^{20}$

10 = Not used

11 = At dc

### CONFIG3: Configuration Register 3

Address = 03h

| BIT 7     | BIT 6 | BIT 5   | BIT 4 | BIT 3     | BIT 2    | BIT 1 | BIT 0 |
|-----------|-------|---------|-------|-----------|----------|-------|-------|
| PD_REFBUF | 1     | VREF_4V | 0     | OPAMP_REF | PD_OPAMP | 0     | 0     |

This register configures multireference operation.

**Bit 7**      **PD\_REFBUF: Power-down reference buffer**

This bit determines the power-down reference buffer state.

0 = Power-down internal reference buffer (default)

1 = Enable internal reference buffer

**Bit 6**      **Must be set to '1'**

Default is '1' at power-up.

**Bit 5**      **VREF\_4V: Reference voltage**

This bit determines the reference voltage, VREFP.

0 = VREFP is set to 2.4 V (default)

1 = VREFP is set to 4 V (only use with a 5-V analog supply)

**Bit 4**      **Must be set to '0'**

**Bit 3**      **OPAMP\_REF: Op amp reference**

This bit determines whether the op amp noninverting input connects to the OPAMP pin or to the internally-derived 1/2 supply  $(AVDD + AVSS) / 2$ .

0 = Noninverting input connected to the OPAMP pin (default)

1 = Noninverting input connected to  $(AVDD + AVSS) / 2$

**Bit 2**      **PD\_OPAMP: Power-down op amp**

This bit determines the power-down reference buffer state.

0 = Power-down op amp (default)

1 = Enable op amp

**Bits[1:0]**      **Must be set to '0'**

**FAULT: Fault Detect Control Register**

Address = 04h

| BIT 7    | BIT 6    | BIT 5    | BIT 4 | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|----------|----------|----------|-------|-------|-------|-------|-------|
| COMP_TH2 | COMP_TH1 | COMP_TH0 | 0     | 0     | 0     | 0     | 0     |

This register configures the fault detection operation.

**Bits[7:5] COMP\_TH[2:0]: Fault detect comparator threshold**

These bits determine the fault detect comparator threshold level setting. See the [Fault Detection](#) section for a detailed description.

**Comparator positive-side threshold**

000 = 95% (default)  
 001 = 92.5%  
 010 = 90%  
 011 = 87.5%  
 100 = 85%  
 101 = 80%  
 110 = 75%  
 111 = 70%

**Comparator negative-side threshold**

000 = 5% (default)  
 001 = 7.5%  
 010 = 10%  
 011 = 12.5%  
 100 = 15%  
 101 = 20%  
 110 = 25%  
 111 = 30%

**Bits[4:0] Must be set to '0'**

### **CHnSET: Individual Channel Settings (n = 1 to 8)**

Address = 05h to 0Ch

| BIT 7 | BIT 6  | BIT 5  | BIT 4  | BIT 3 | BIT 2 | BIT 1 | BIT 0 |
|-------|--------|--------|--------|-------|-------|-------|-------|
| PDn   | GAINn2 | GAINn1 | GAINn0 | 0     | MUXn2 | MUXn1 | MUXn0 |

The CH[8:1]SET Control Register configures the power mode, PGA gain, and multiplexer setting channels. See the [Input Multiplexer](#) section for details. CH[8:2]SET are similar to CH1SET, corresponding to the respective channels (refer to [Table 6](#)).

**Bit 7**            **PDn: Power-down (n = individual channel number)**  
This bit determines the channel power mode for the corresponding channel.  
0 = Normal operation (default)  
1 = Channel power-down

**Bits[6:4]**      **GAINn[2:0]: PGA gain (n = individual channel number)**  
These bits determine the PGA gain setting.  
000 = Do not use  
001 = x1  
010 = x2  
011 = Do not use  
100 = Do not use  
101 = x8  
110 = Do not use  
111 = Do not use

**Bit 3**            **Must be set to '0'**

**Bits[2:0]**      **MUXn[2:0]: Channel input (n = individual channel number)**  
These bits determine the channel input selection.  
000 = Normal input (default)  
001 = Input shorted (for offset or noise measurements)  
010 = Do not use  
011 = MVDD for supply measurement  
100 = Temperature sensor  
101 = Test signal  
110 = Do not use  
111 = Do not use

**FAULT\_STATP: Fault Detect Positive Input Status**

Address = 12h

| BIT 7      | BIT 6      | BIT 5      | BIT 4      | BIT 3      | BIT 2      | BIT 1      | BIT 0      |
|------------|------------|------------|------------|------------|------------|------------|------------|
| IN8P_FAULT | IN7P_FAULT | IN6P_FAULT | IN5P_FAULT | IN4P_FAULT | IN3P_FAULT | IN2P_FAULT | IN1P_FAULT |

This register stores the status of whether a fault condition is present on the positive electrode of each channel. See the [Fault Detection](#) section for details.

**Bits[7:0]      INnP\_FAULT: Input fault status (n = individual channel number)**  
 0 = No fault present (default)  
 1 = Fault present

**FAULT\_STATN: Fault Detect Negative Input Status**

Address = 13h

| BIT 7      | BIT 6      | BIT 5      | BIT 4      | BIT 3      | BIT 2      | BIT 1      | BIT 0      |
|------------|------------|------------|------------|------------|------------|------------|------------|
| IN8N_FAULT | IN7N_FAULT | IN6N_FAULT | IN5N_FAULT | IN4N_FAULT | IN3N_FAULT | IN2N_FAULT | IN1N_FAULT |

This register stores the status of whether a fault condition is present on the negative electrode of each channel. See the [Fault Detection](#) section for details.

**Bits[7:0]      INnN\_FAULT: Input fault status (n = individual channel number)**  
 0 = No fault present (default)  
 1 = Fault present

**GPIO: General-Purpose IO Register**

Address = 14h

| BIT 7  | BIT 6  | BIT 5  | BIT 4  | BIT 3  | BIT 2  | BIT 1  | BIT 0  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| GPIOD4 | GPIOD3 | GPIOD2 | GPIOD1 | GPIOC4 | GPIOC3 | GPIOC2 | GPIOC1 |

This register controls the action of the three GPIO pins.

**Bits[7:4]      GPIOD[4:1]: GPIO data**  
 These bits are used to read and write data to the GPIO ports.  
 When reading the register, the data returned correspond to the state of the GPIO external pins, whether they are programmed as inputs or outputs. As outputs, a write to the GPIOD sets the output value. As inputs, a write to the GPIOD has no effect.

**Bits[3:0]      GPIOC[4:1]: GPIO control (corresponding to GPIOD)**  
 These bits determine if the corresponding GPIOD pin is an input or output.  
 0 = Output  
 1 = Input (default)

## POWER-MONITORING SPECIFIC APPLICATIONS

All ADS130E08 channels are independently configurable, allowing any channel to be selected for voltage or current monitoring. Also, the simultaneously sampling capability of the device allows both current and voltage to be monitored at the same time. The full-scale differential input voltage of each channel is determined by the PGA gain setting (see the [CHnSET: Individual Channel Settings](#) section) for the respective channel and  $V_{REF}$  (see the [CONFIG3: Configuration Register 3](#) section). [Table 7](#) summarizes the full-scale differential input voltage range for an internal  $V_{REF}$ .

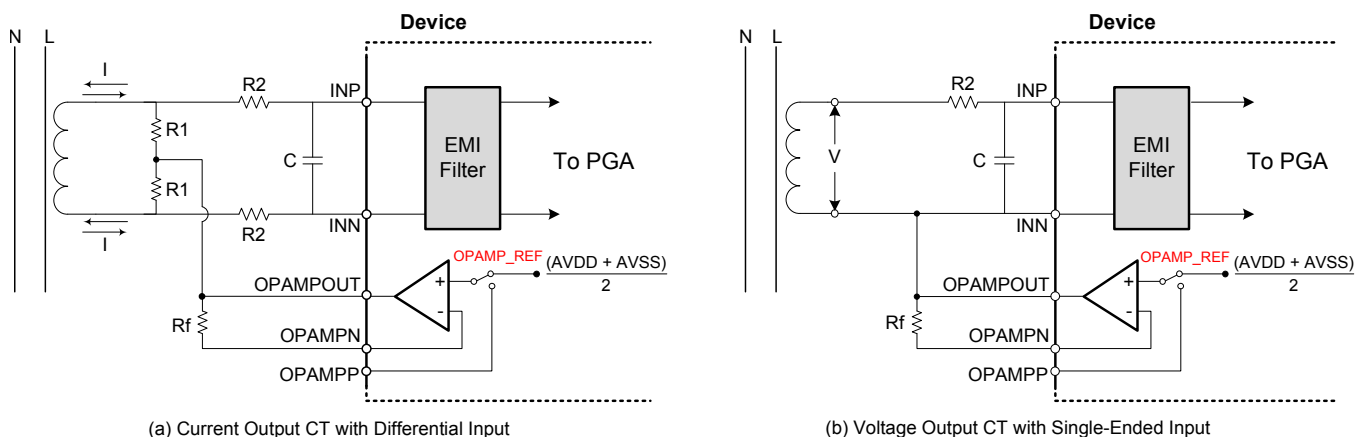
**Table 7. Full-Scale Differential Input (FSDI) Voltage Summary**

| $V_{REF}$ | PGA GAIN | FULL-SCALE DIFFERENTIAL INPUT VOLTAGE ( $V_{PP}$ ) | RMS VOLTAGE [= FSDI / ( $2\sqrt{2}$ )] ( $V_{RMS}$ ) |
|-----------|----------|----------------------------------------------------|------------------------------------------------------|
| 2.4 V     | 1        | 4.8                                                | 1.698                                                |
|           | 2        | 2.4                                                | 0.849                                                |
|           | 8        | 0.6                                                | 0.212                                                |
| 4.0 V     | 1        | 8.0                                                | 2.828                                                |
|           | 2        | 4.0                                                | 1.414                                                |
|           | 8        | 1                                                  | 0.354                                                |

## CURRENT SENSING

[Figure 41](#) shows a simplified diagram of typical configurations used for current sensing with a Rogowski coil, current transformer (CT), or an air coil that outputs a current or voltage. In the case of current-output transformers, the burden resistors ( $R1$ ) are used for current-to-voltage conversion. The burden resistor output is connected to the ADS130E08 INP and INN inputs through an antialiasing RC filter for current sensing. In the case of voltage-output transformers (such as certain types of Rogowski coils), the transformer output terminals are directly connected to the ADS130E08 INP and INN inputs through an antialiasing RC filter for current sensing. The common-mode bias voltage ( $AVDD + AVSS$ ) / 2, can be obtained from the ADS130E08 by either configuring the internal op amp in a unity-gain configuration using the  $R_F$  resistor and setting bit 3 of [CONFIG3: Configuration Register 3](#), or it can be generated externally with a simple resistor divider network between the positive and negative supplies.

The resistor  $R1$  value for the current-output transformer, the output voltage ( $V$ ) for the voltage-output transformer, and the turns ratio of the transformer should be carefully selected so as not to exceed the ADS130E08 FSDI range (see [Table 7](#)). Furthermore, these values should not saturate the transformer over the full operating dynamic range of the energy meter. [Figure 41a](#) shows differential input current sensing and [Figure 41b](#) shows single-ended input sensing.

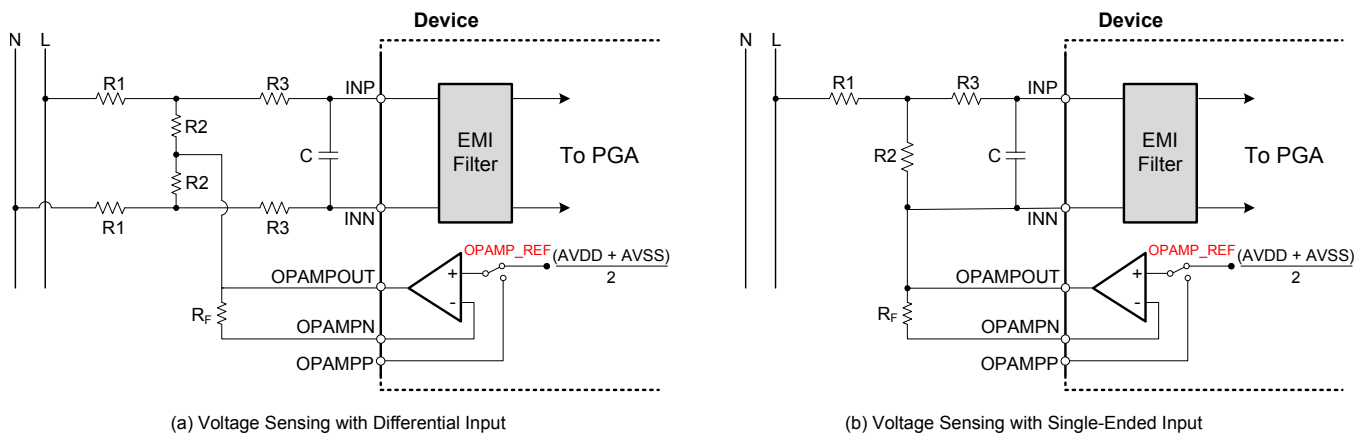


**Figure 41. Simplified Current-Sensing Connections**

## VOLTAGE SENSING

Figure 42 shows a simplified diagram of commonly-used differential and single-ended methods of voltage sensing. A resistor divider network is used to step down the line voltage within the acceptable input range of the ADS130E08 and then directly connect to the inputs (INP and INN) through an antialiasing RC filter formed by resistor R3 and capacitor C. The common-mode bias voltage  $(AVDD + AVSS) / 2$ , can be obtained from the ADS130E08 by either configuring the internal op amp in a unity-gain configuration using the  $R_F$  resistor and setting bit 3 of [CONFIG3: Configuration Register 3](#), or it can be generated externally by using a simple resistor divider network between the positive and negative supplies.

In either case presented in Figure 42 (Figure 42a for a differential input and Figure 42b for a single-ended input), the line voltage is divided down by a factor of  $[R2 / (R1 + R2)]$ . R1 and R2 values must be carefully chosen so that the voltage across the ADS130E08 inputs (INP and INN) does not exceed the ADS130E08 FSDI range (see [Table 7](#)) over the full operating dynamic range of the energy meter.

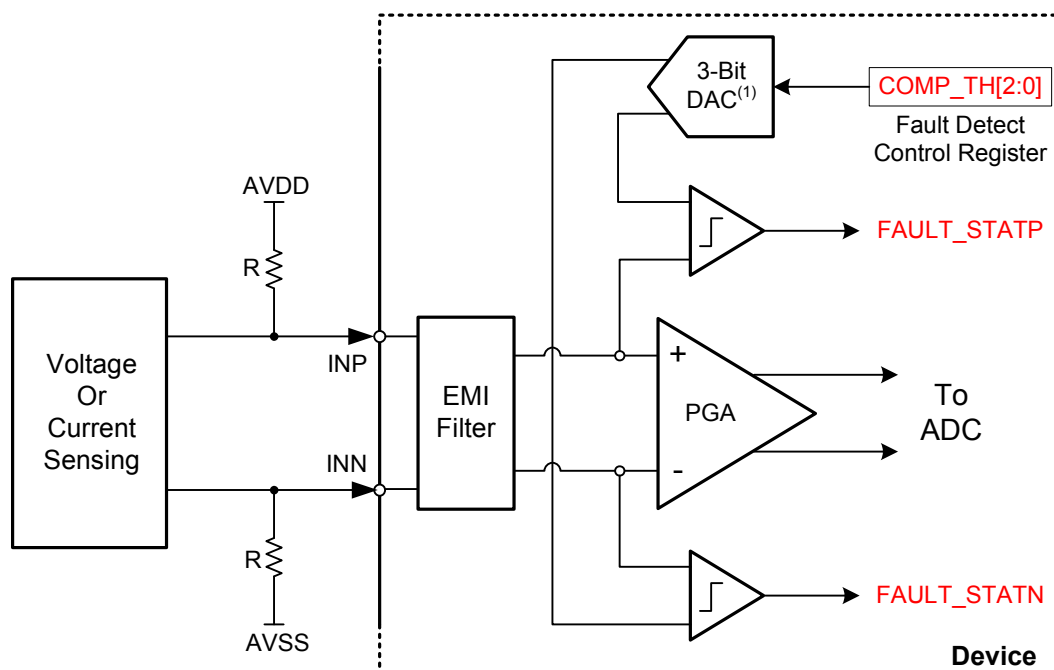


**Figure 42. Simplified Voltage Sensing Connections**

## FAULT DETECTION

The ADS130E08 has integrated comparators that can be used in conjunction with the external pull-up or pull-down resistors (R) to detect various fault conditions. The basic principle is to compare the input voltage with the voltage set by the 3-bit DAC fault comparator, as shown in Figure 43. The comparator trigger threshold level is set by the COMP\_TH[2:0] bits in the FAULT register. Assuming that the ADS130E08 is powered from a  $\pm 2.5$ -V supply and COMP\_TH[2:0] = 000 (95% and 5%), the high-side trigger threshold is set at +2.25 V [equal to AVSS + (AVDD + AVSS)  $\times$  95%] and the low-side threshold is set at -2.25 V [equal to AVSS + (AVDD + AVSS)  $\times$  5%]. The threshold calculation formula applies to unipolar as well as bipolar supplies.

A fault condition, such as an input signal going out of a predetermined range, can be detected by setting the appropriate threshold level using the COMP\_TH[2:0] bits. An open-circuit fault at the INP or INN pin can be detected by using the external pull-up and pull-down resistors, which rails the corresponding input when the input circuit breaks, causing the fault comparators to trip. To pinpoint which of the inputs is out of range, the status of the FAULT\_STATP and FAULT\_STATN registers can be read, which is available as part of the output data stream; see the *Data Output (DOUT)* subsection of the *SPI Interface* section.



(1) The configurable 3-bit DAC is common to all channels.

Figure 43. Fault Detect Comparators

## QUICK-START GUIDE

### PCB LAYOUT

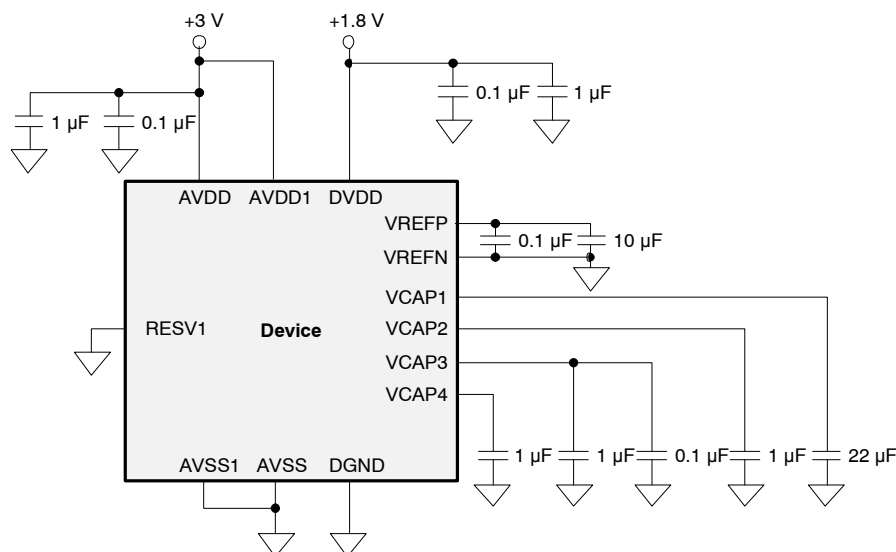
#### Power Supplies and Grounding

The ADS130E08 has three supplies: AVDD, AVDD1, and DVDD. Both AVDD and AVDD1 should be as quiet as possible. AVDD1 provides the supply to the charge pump block and has transients at  $f_{CLK}$ . Therefore, AVDD1 and AVSS1 are recommended to be star-connected to AVDD and AVSS. It is important to eliminate noise from AVDD and AVDD1 that is non-synchronous with the ADS130E08 operation. Each ADS130E08 supply should be bypassed with 10- $\mu$ F and a 0.1- $\mu$ F solid ceramic capacitors. It is recommended that placement of the digital circuits (such as DSPs, microcontrollers, and FPGAs) in the system be done such that the return currents on those devices do not cross the ADS130E08 analog return path. The ADS130E08 can be powered from unipolar or bipolar supplies.

The capacitors used for decoupling can be surface-mount, low-cost, low-profile multilayer ceramic capacitors. In most cases the VCAP1 capacitor can also be a multilayer ceramic. However, in systems where the board is subjected to high- or low-frequency vibration, it is recommend that a non-ferroelectric capacitor such as a tantalum or class 1 capacitor (C0G or NPO for example) be installed. EIA class 2 and class 3 dielectrics (such as X7R, X5R, and X8R) are ferroelectric. The piezoelectric property of these capacitors can appear as electrical noise coming from the capacitor. When using the internal reference, noise on the VCAP1 node results in performance degradation.

#### Connecting the Device to Unipolar (+3 V or +1.8 V) Supplies

Figure 44 shows the ADS130E08 connected to a unipolar supply. In this example, the analog supply (AVDD) is referenced to analog ground (AVSS) and the digital supplies (DVDD) are referenced to digital ground (DGND).

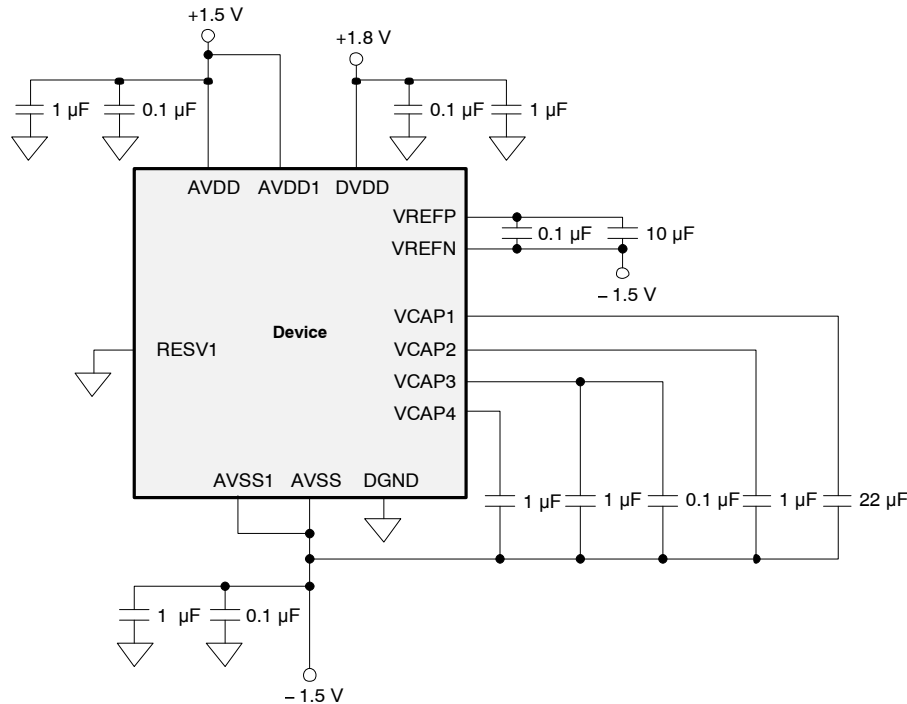


NOTE: Place the capacitors for supply, reference, and VCAP1 to VCAP4 as close to the package as possible.

**Figure 44. Single-Supply Operation**

### Connecting the Device to Bipolar ( $\pm 1.5$ V or 1.8 V) Supplies

Figure 45 illustrates the ADS130E08 connected to a bipolar supply. In this example, the analog supplies connect to the device analog supply (AVDD). This supply is referenced to the device analog ground return (AVSS), and the digital supply (DVDD) is referenced to the device digital ground return (DGND).



NOTE: Place the capacitors for supply, reference, and VCAP1 to VCAP4 as close to the package as possible.

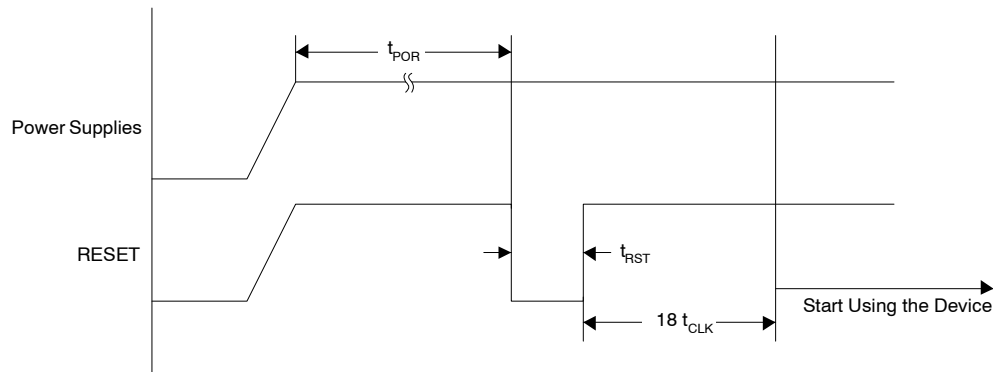
**Figure 45. Bipolar Supply Operation**

### Shielding Analog Signal Paths

As with any precision circuit, careful PCB layout ensures the best performance. It is essential to make short, direct interconnections and avoid stray wiring capacitance—particularly at the analog input pins and AVSS. These analog input pins are high-impedance and extremely sensitive to extraneous noise. The AVSS pin should be treated as a sensitive analog signal and connected directly to the supply ground with proper shielding. Leakage currents between the PCB traces can exceed the ADS130E08 input bias current if shielding is not implemented. Digital signals should be kept as far as possible from the analog input signals on the PCB.

## POWER-UP SEQUENCING

Before device power-up, all digital and analog inputs must be low. At the time of power-up, all of these signals should remain low until the power supplies have stabilized, as shown in [Figure 46](#). At this time, begin supplying the master clock signal to the CLK pin. Wait for time  $t_{POR}$ , then transmit a RESET pulse. After releasing RESET, the configuration register must be programmed (see the [CONFIG1: Configuration Register 1](#) subsection of the [Register Map](#) section for details). The power-up sequence timing is shown in [Table 8](#).



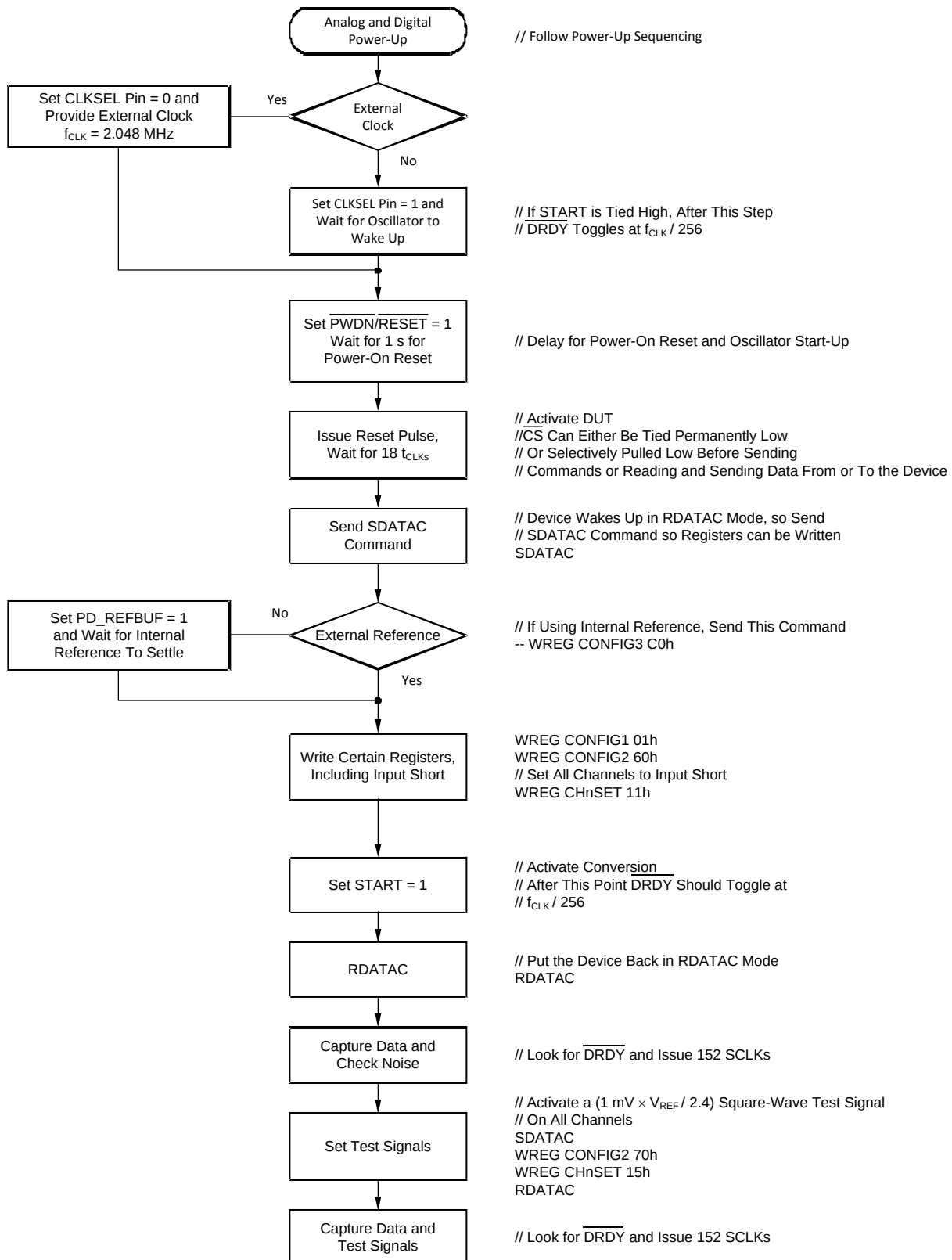
**Figure 46. Power-Up Timing Diagram**

**Table 8. Power-Up Sequence Timing**

| SYMBOL    | DESCRIPTION                     | MIN      | TYP | MAX | UNIT      |
|-----------|---------------------------------|----------|-----|-----|-----------|
| $t_{POR}$ | Wait after power-up until reset | $2^{16}$ |     |     | $t_{CLK}$ |
| $t_{RST}$ | Reset low width                 | 2        |     |     | $t_{CLK}$ |

## SETTING THE DEVICE FOR BASIC DATA CAPTURE

This section outlines the procedure to configure the device in a basic state and capture data. This procedure is intended to put the device in a data sheet condition to check if the device is working properly in the user system. This procedure is recommended to be followed initially to get familiar with the device settings. When this procedure is verified, the device can be configured as needed. For details on the timings for commands refer to the appropriate sections in the data sheet. The flow chart of [Figure 47](#) details the initial configuration and setup of the ADS130E08.



**Figure 47. Initial Flow at Power-Up**

## REVISION HISTORY

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Original (July 2012) to Revision A                                                                     | Page |
|---------------------------------------------------------------------------------------------------------------------|------|
| • Changed pin out drawing .....                                                                                     | 7    |
| • Added CLKSEL row to Pin Assignments table .....                                                                   | 7    |
| • Deleted terminal 52 from DGND row in Pin Assignments table .....                                                  | 7    |
| • Added cross-reference to <a href="#">Figure 29</a> in second paragraph of <i>Data Ready</i> section .....         | 23   |
| • Changed description of GPIO pin connections in <i>GPIO</i> section .....                                          | 23   |
| • Deleted last sentence in description paragraph in <i>FAULT_STATP</i> and <i>FAULT_STATN</i> sections .....        | 38   |
| • Changed Bits[1:0] to Bits[3:0] in GPIOC description in the <i>GPIO: General-Purpose IO Register</i> section ..... | 38   |

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| ADS130E08IPAG    | ACTIVE        | TQFP         | PAG                | 64   | 160            | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 105   | ADS130E08               | <a href="#">Samples</a> |
| ADS130E08IPAGR   | ACTIVE        | TQFP         | PAG                | 64   | 1500           | Green (RoHS<br>& no Sb/Br) | NIPDAU                  | Level-3-260C-168 HR  | -40 to 105   | ADS130E08               | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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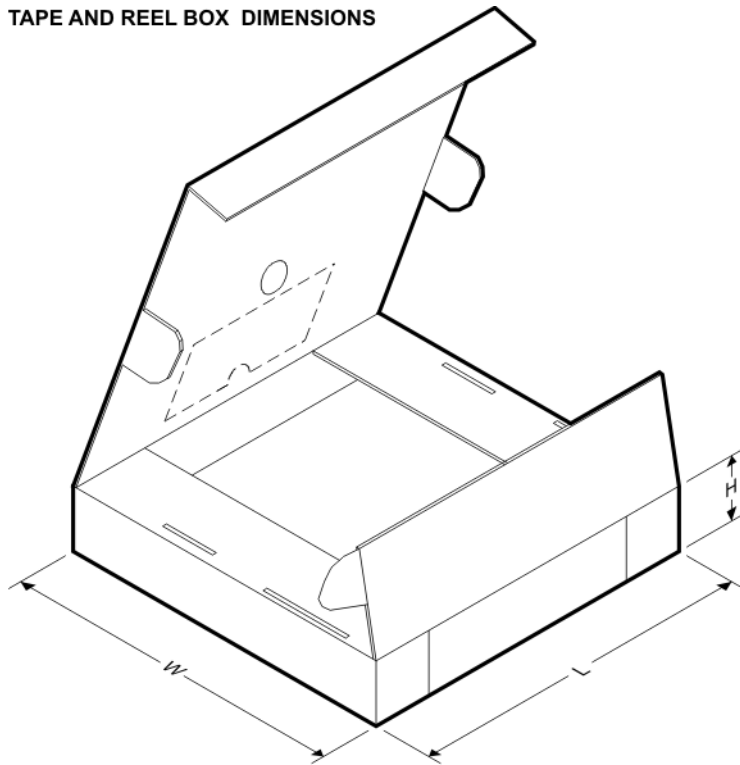


**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|----------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS130E08IPAGR | TQFP         | PAG             | 64   | 1500 | 330.0              | 24.4               | 13.0    | 13.0    | 1.5     | 16.0    | 24.0   | Q2            |

## TAPE AND REEL BOX DIMENSIONS

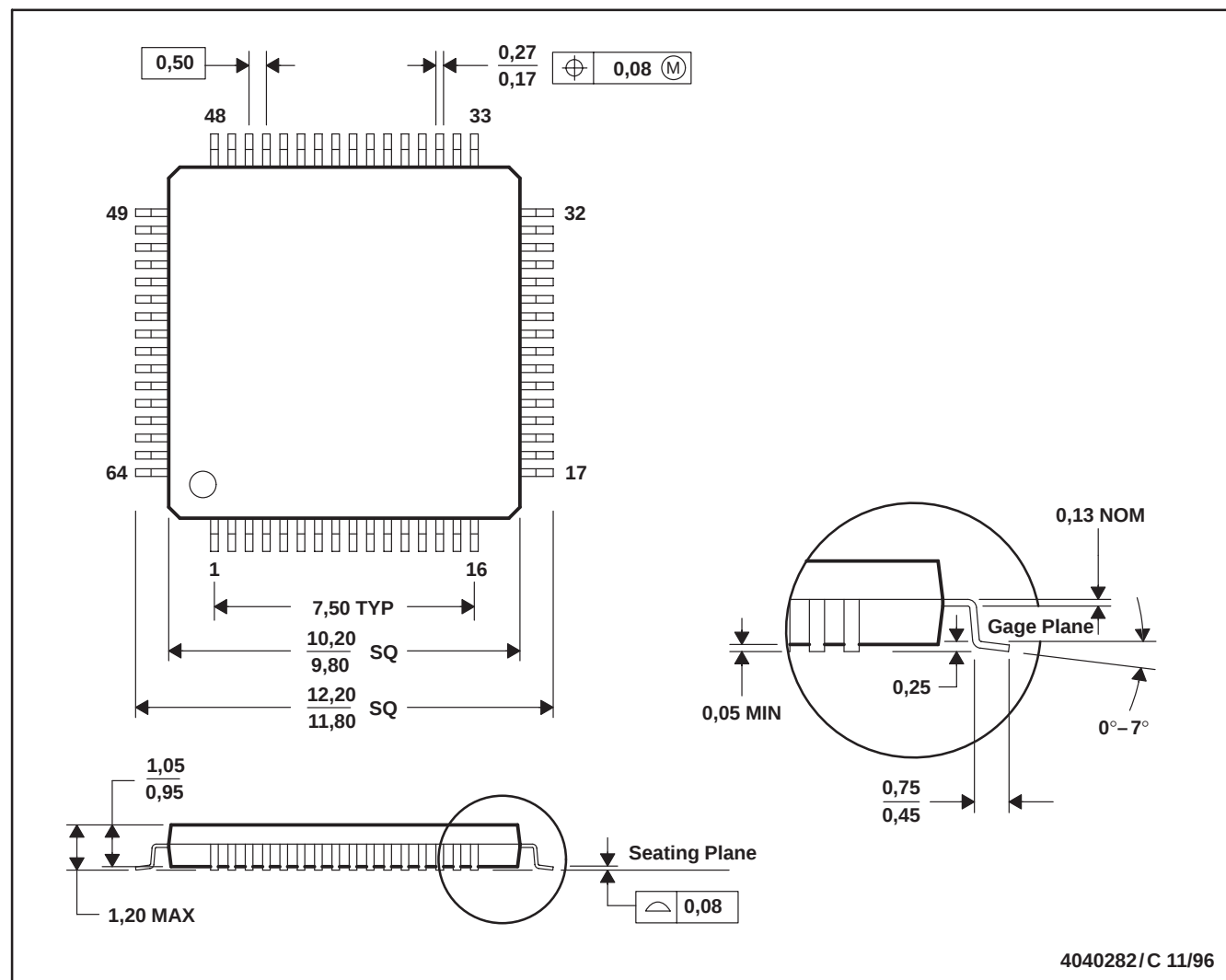


\*All dimensions are nominal

| Device         | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS130E08IPAGR | TQFP         | PAG             | 64   | 1500 | 350.0       | 350.0      | 43.0        |

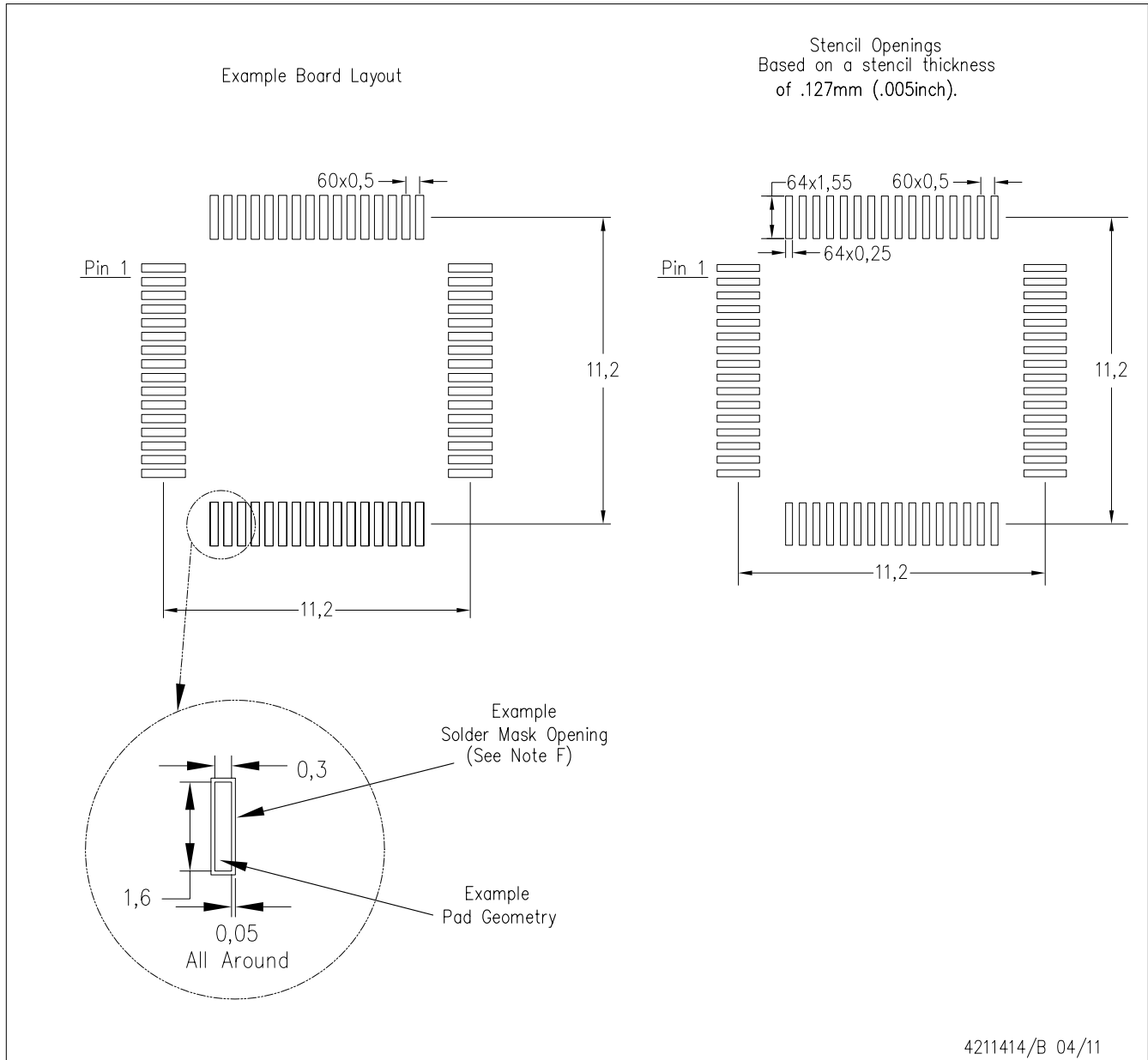
## PAG (S-PQFP-G64)

## PLASTIC QUAD FLATPACK



PAG (S-PQFP-G64)

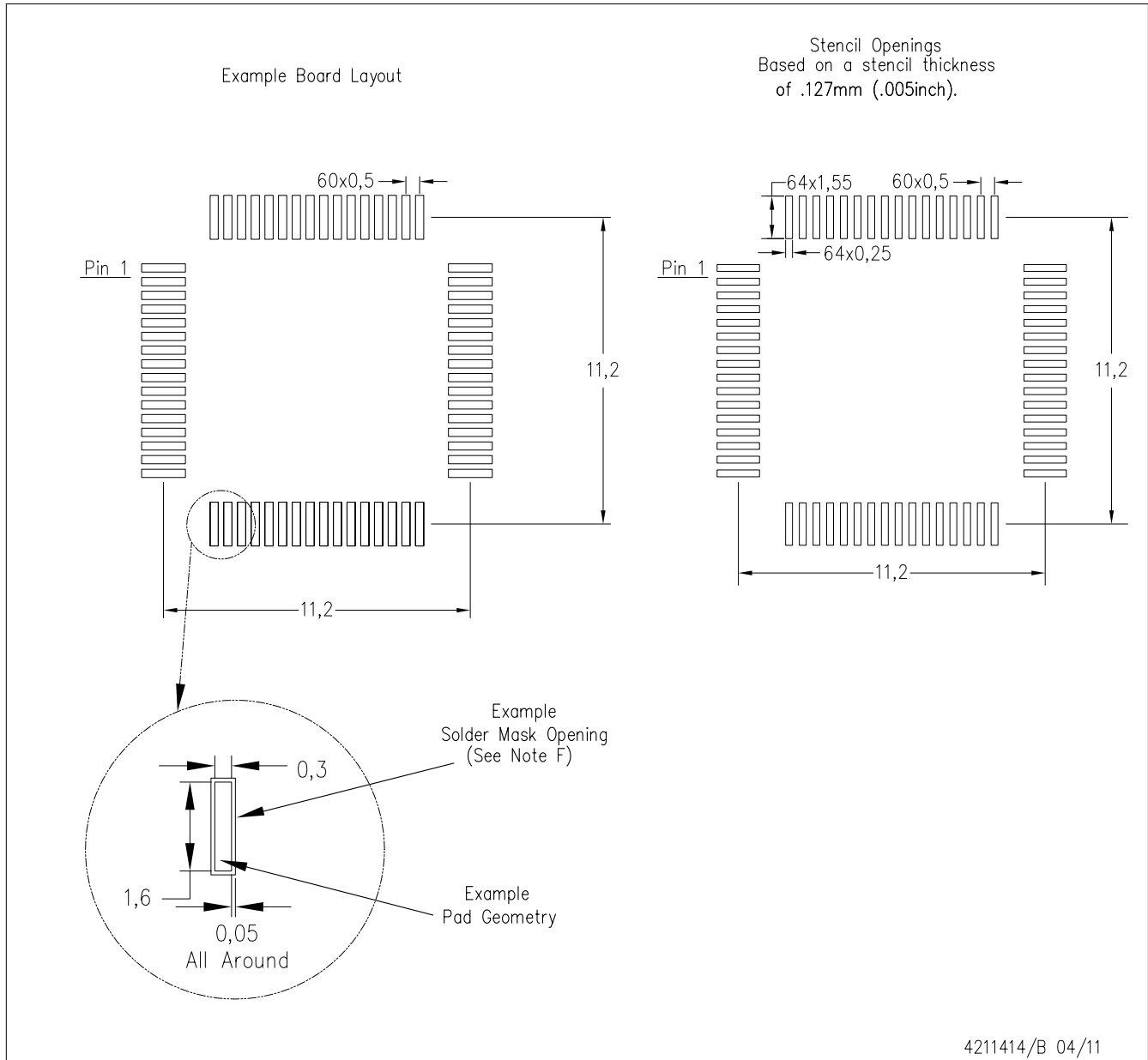
PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
  - D. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PAG (S-PQFP-G64)

PLASTIC QUAD FLATPACK



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.
  - D. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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